

Wafer-Level Calibration & Verification up to 750 GHz

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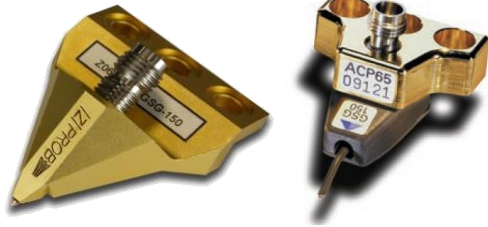
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2016

■ Outline

- LRRM vs SOLT
- Calibration Verification
- Over-temperature RF calibration
- 110 GHz 4 port Calibration & Validation
- Sub-THz Wafer Level VNA Calibration

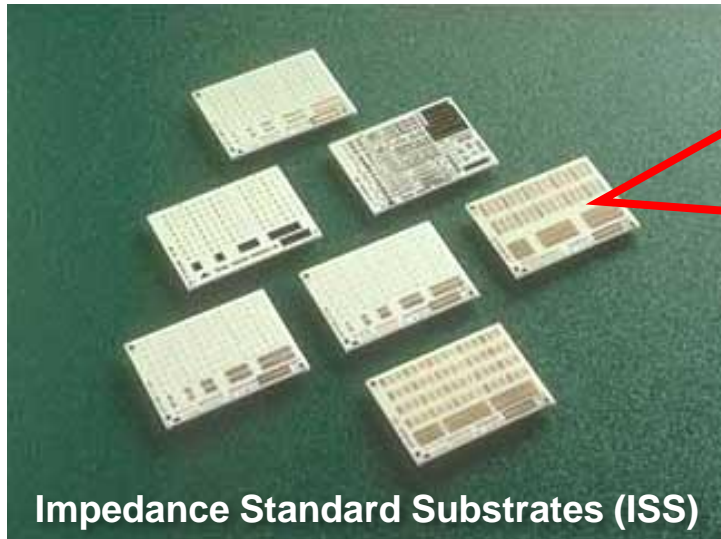
On-Wafer RF Measurements



Air Coplanar Probes



Probes with Microstrip Design



Impedance Standard Substrates (ISS)

Electrical behavior

- standard dimensions
- probe pitch
- probe placement

SHORT

LOAD

THRU

■ The Need for VNA Calibration



■ Systematic Errors

- Imperfections in Network Analyzer and Test setup
- Define the measurement reference plane in a Test setup



■ Random Errors

- Vary with time in Random Fashion (Unpredictable)
- Main Contributors: Instrument noise, switch and connector repeatability.



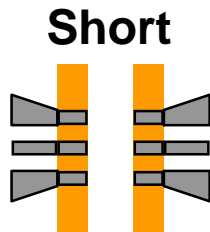
■ Drift Errors

- Due to System performance changing after a calibration has been done.
- Primarily cause by Temperature Variation

■ When to Recalibrate?

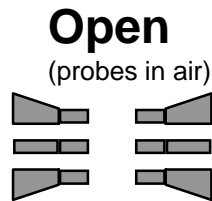
- Perform **System Stability Check**

SOLT Calibration



Short

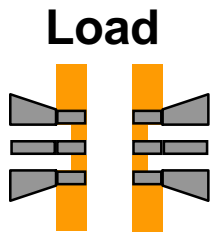
L_{short}



Open

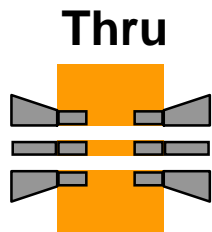
(probes in air)

C_{open}



Load

L_{term}

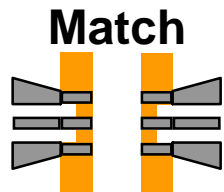
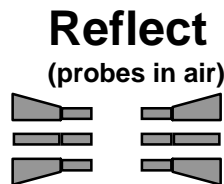
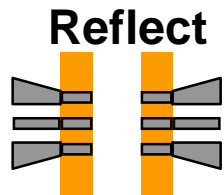
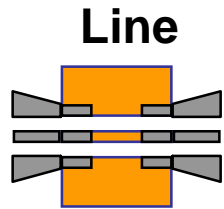


Thru

Delay_{Thru}

- Oldest calibration technique
- All standards must be perfectly known
 - Available every vector network analyzer (CalKit required)
 - Open has capacitance/Inductances
 - Short and load have inductances
- Cal coefficients are defined for a particular probe placement
- Sensitive to probe placement
- Looks best after calibration
- Forces VNA to correct itself based on Cal Coefficients
- How about over-temperature?

■ LRRM Calibration



- Same Standards as SOLT
- Industry Standard verified by NIST
- Line-Reflect-Reflect-Match Calibration
 - Only need to know Thru (line) delay & Match resistance
 - Measurements referenced to trimmed resistor
 - Dynamic Load Inductance Extraction
 - Minimize probe placement sensitivity, providing accurate load inductance extraction
 - Improves the accuracy of reference impedance
- Robust and Accurate
 - Less sensitive to probe placement errors
 - Requires less information about standards

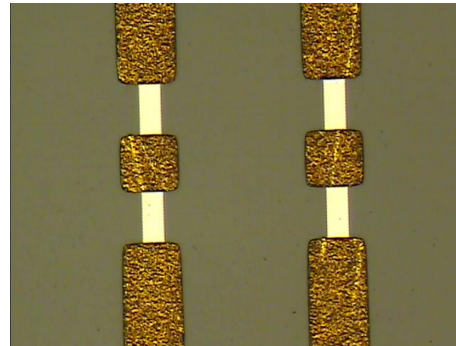
■ SOLT vs LRRM Calibration

- Experiment:
 - Infinity probes GSG pitch 100 μ m Probes
 - ISS 101-190

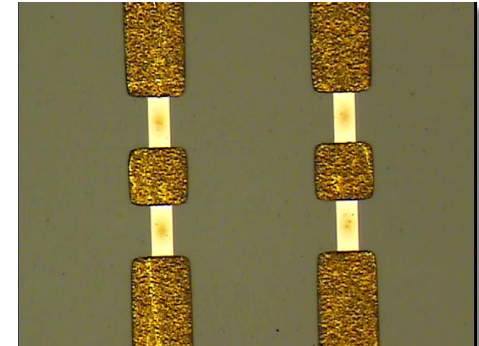
Calibration Technique	SOLT	LRRM
OPEN Capacitance (fF)	-6.5	Not Required
SHORT Inductance (pH)	3.3	Not Required
Load (Ohm)	50	50
Load Inductance (pH)	-0.4	Automatically Determined
Thru' Delay	1ps	1ps

■ 50 Ohm and Thru' Standards

- 50 Ohm Standard
 - Use only precision trimmed loads marked on the ISS maps.
 - $\pm 0.3\%$ accuracy.

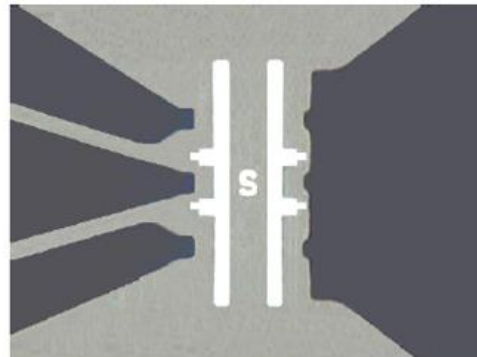


Untrimmed Loads

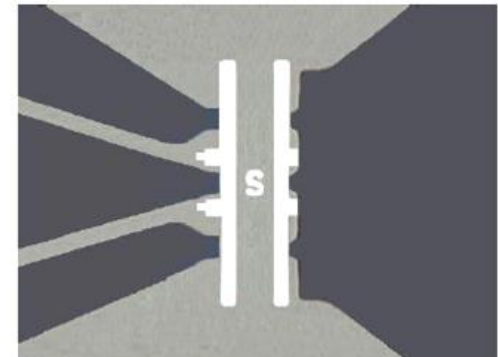


Trimmed Loads

- 1ps Thru' Standard
 - Use alignment marks to maintain correct probe separation distance.



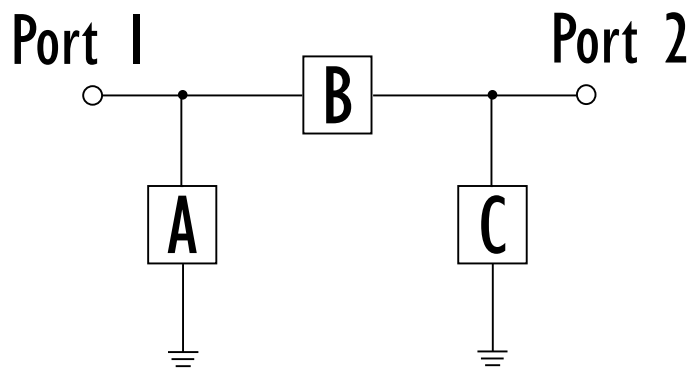
Initial Contact



Final Contact

■ Measure OPEN & SHORT after LRRM Calibration

- Probes are calibrated using LRRM and then, 2 measurements are made:
 - Probes lifted in the air (OPEN)
 - Separate SHORT standard
- Using π network & Admittance (S to Y) parameters to extract OPEN cap and SHORT Inductance



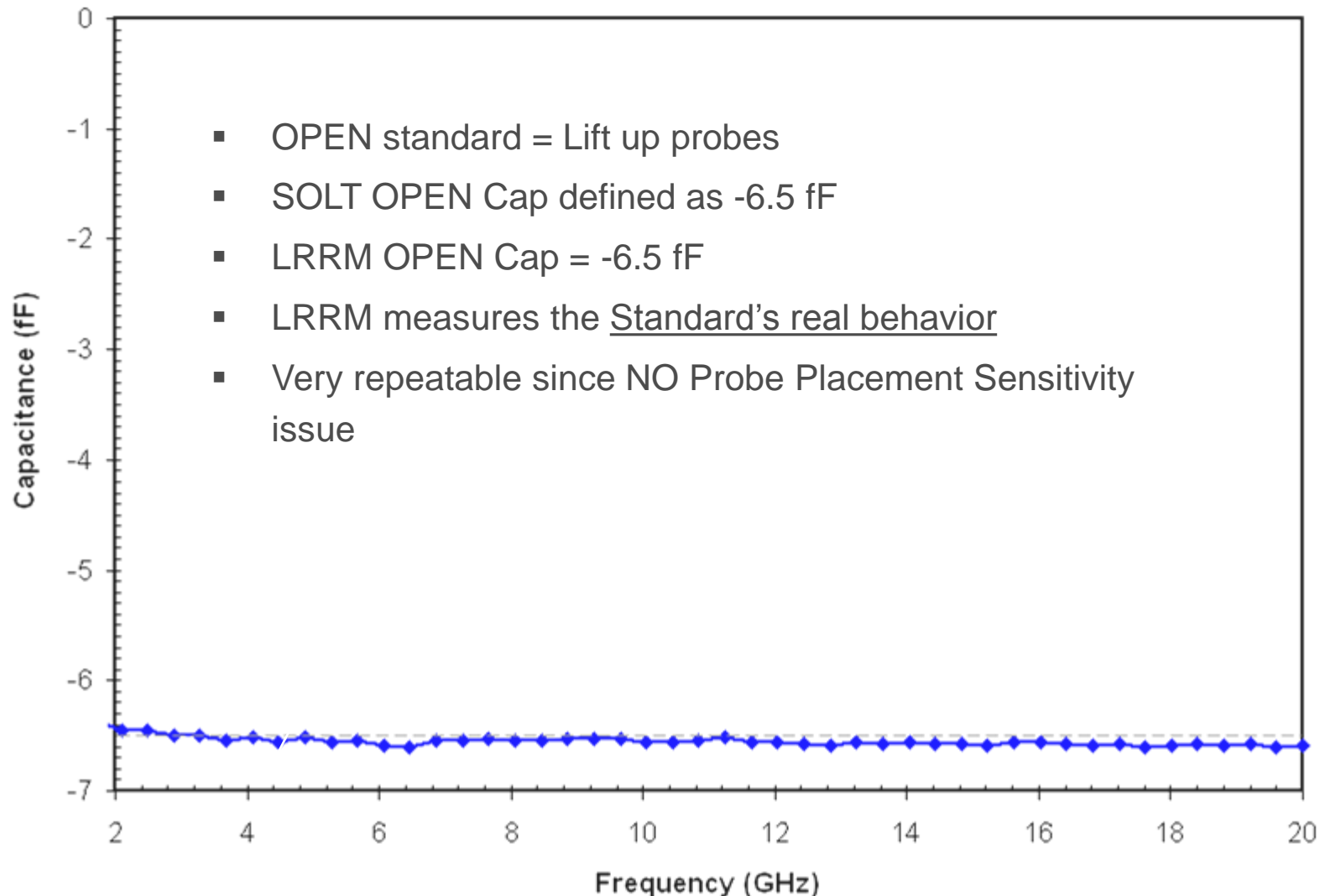
$$\begin{bmatrix} Y_{11} & Y_{12} \\ Y_{21} & Y_{22} \end{bmatrix} = \begin{bmatrix} A + B & -B \\ -B & C + B \end{bmatrix}$$

$$A = Y_{11} + Y_{12}$$

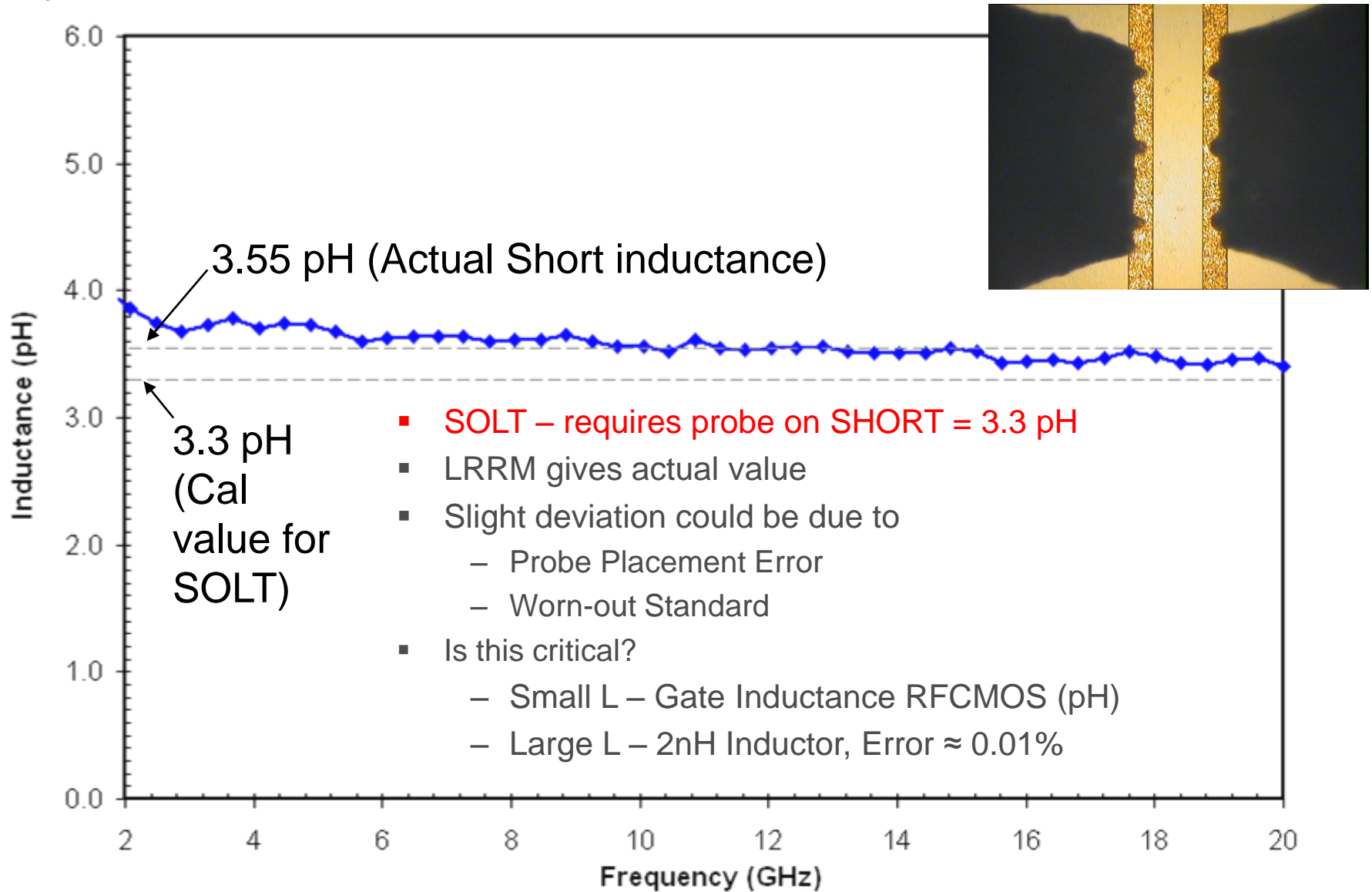
$$C = Y_{22} + Y_{21}$$

$$B = -Y_{12} \text{ or } -Y_{21}$$

■ OPEN Standard measured with LRRM



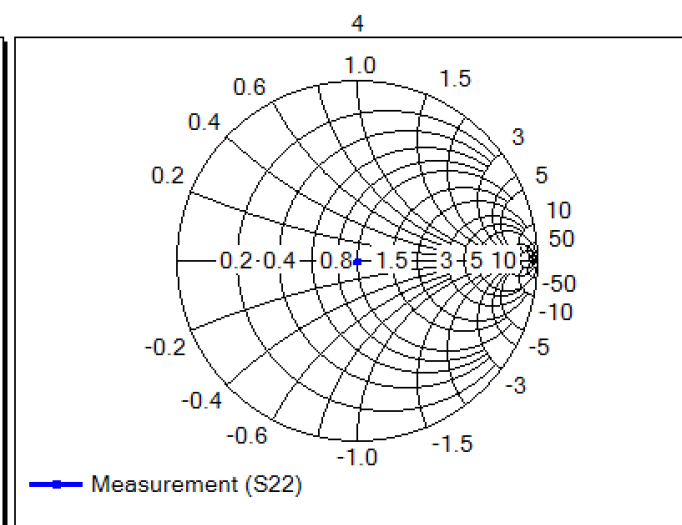
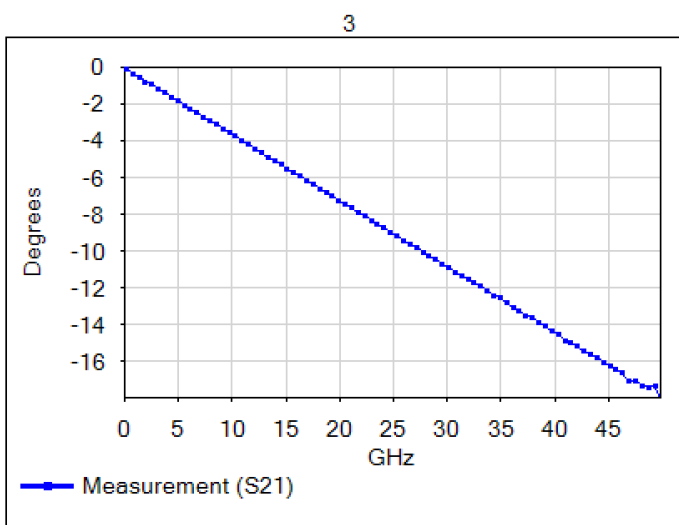
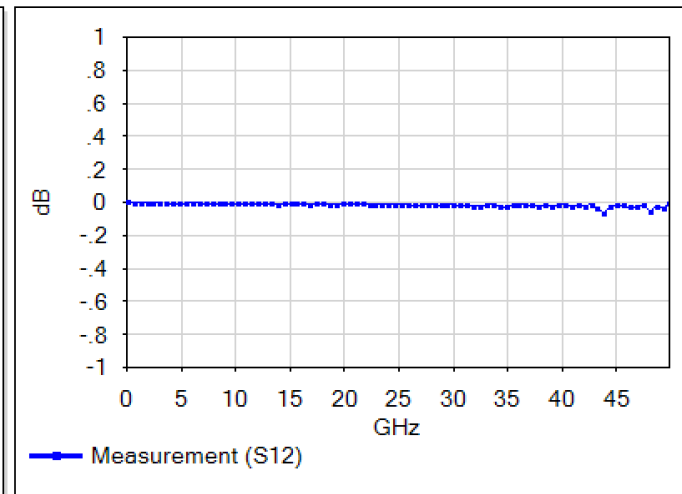
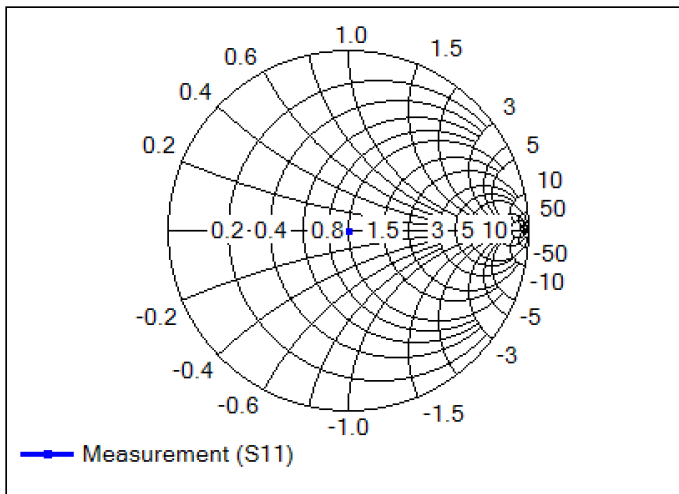
■ SHORT Standard measured with LRRM



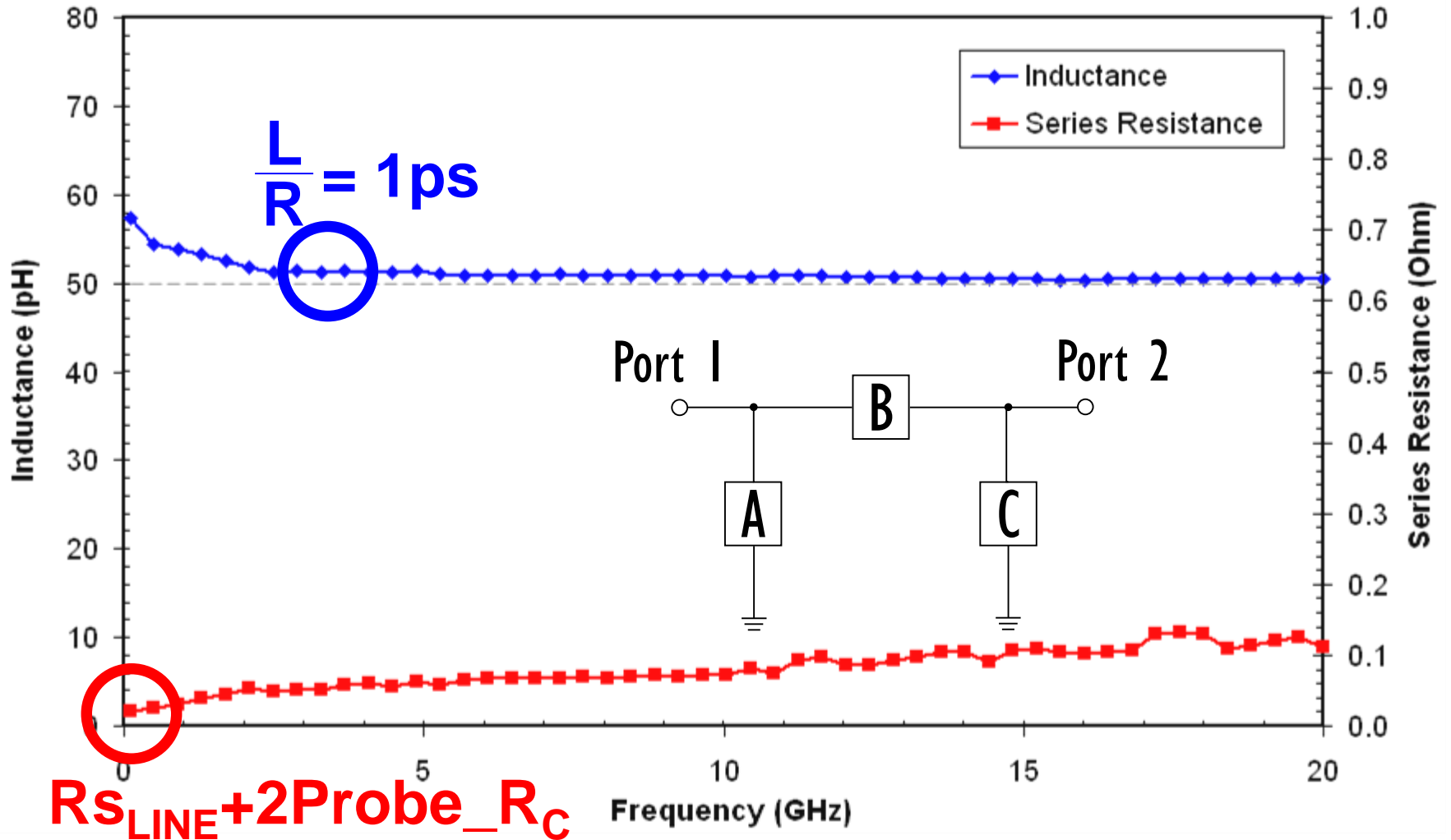


Calibration Verification

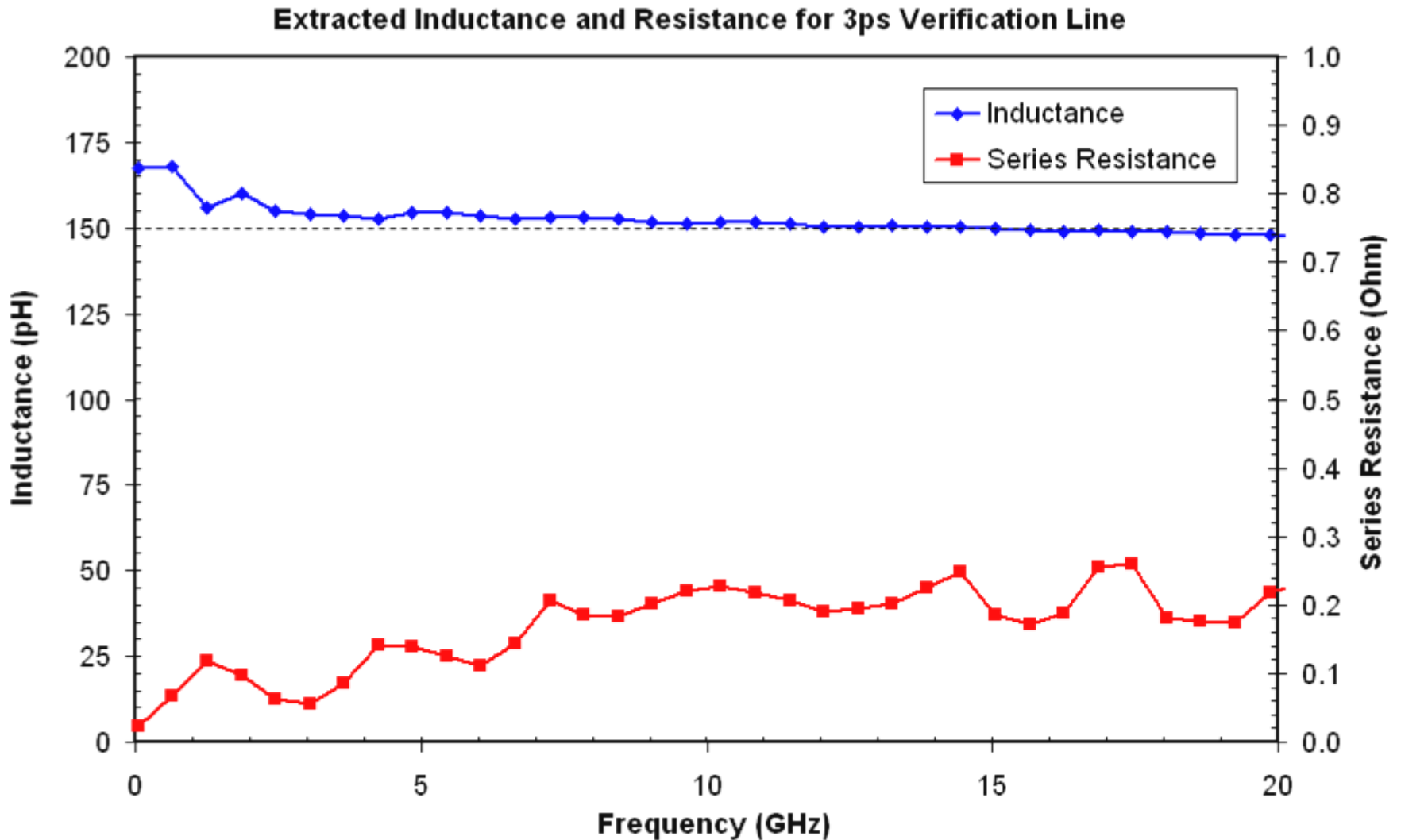
1ps Verification Line



1ps Verification Line



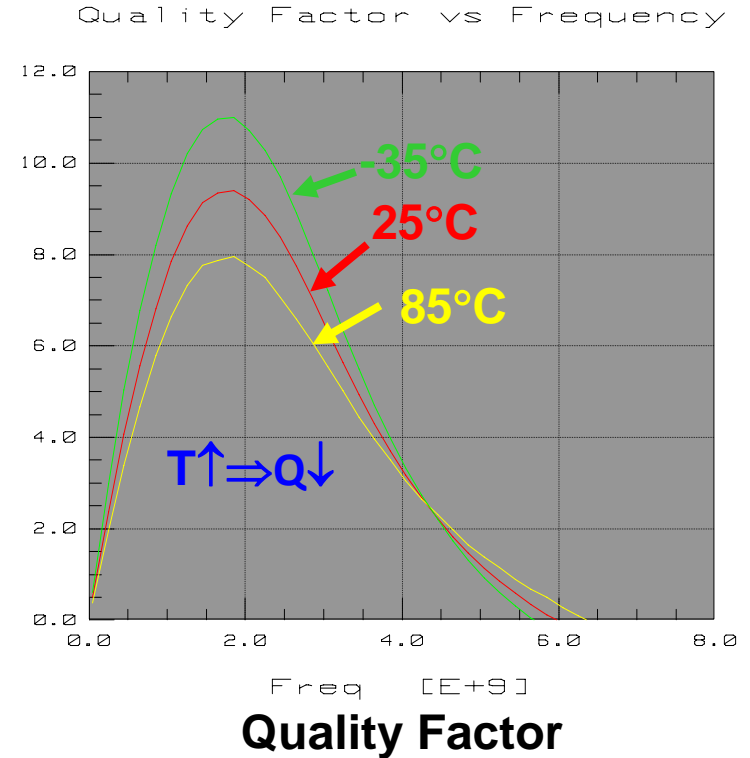
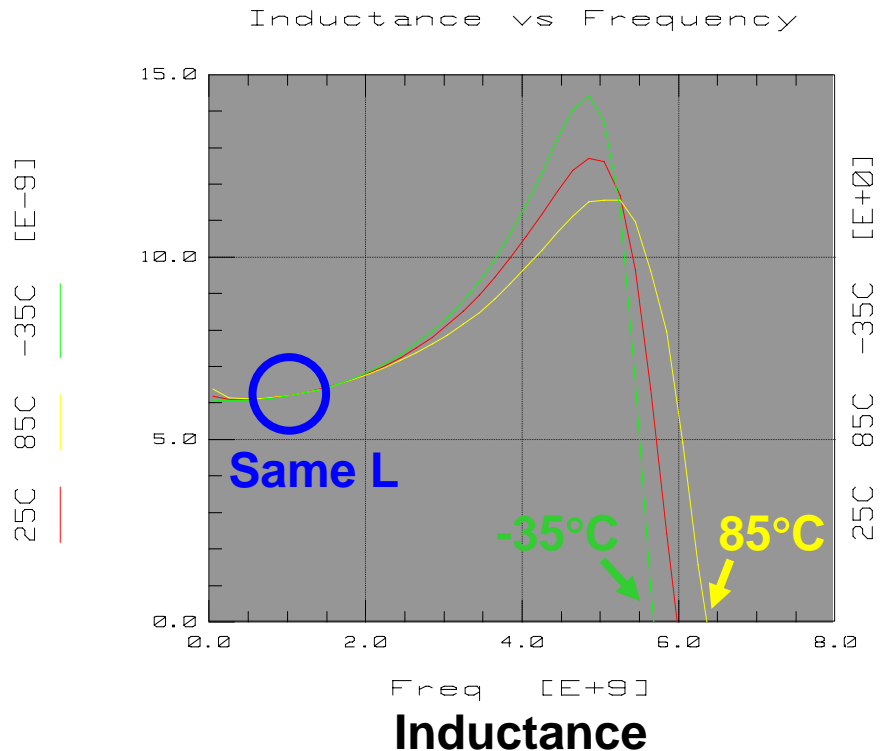
3ps Verification Line





RF Over-Temperature Calibration

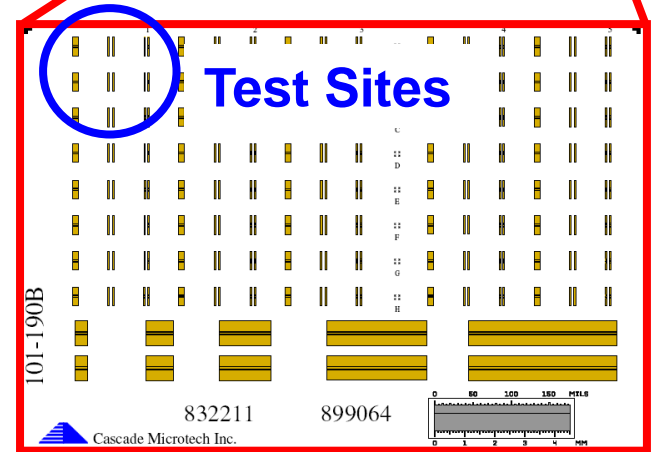
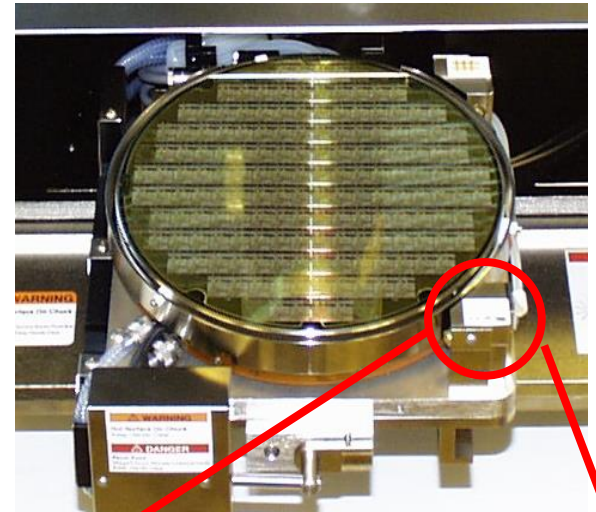
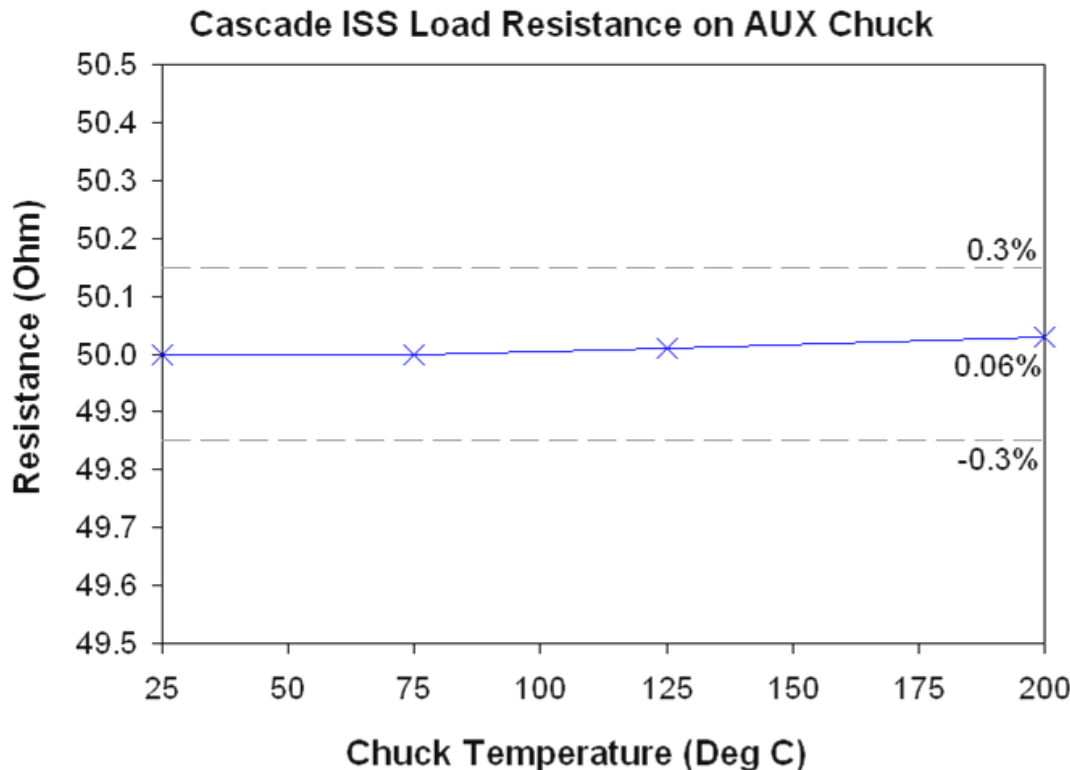
Example of RF Over-Temperature Device Measurement – Inductor (N5W10D120)



- MUST characterize devices at operating temperatures
- Device models must predict temperature effects

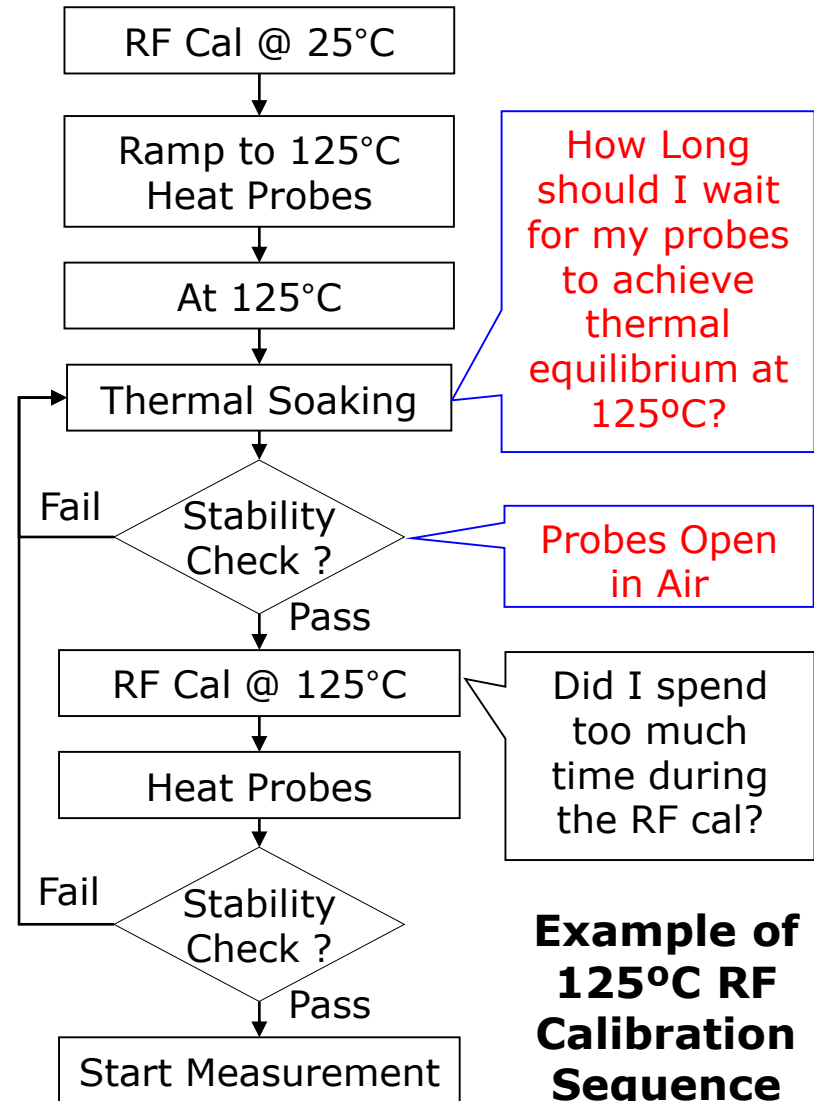
Over-temperature RF Probe Calibration

1. Load std = 50 Ohms at all temperatures
(Standards must be thermally Isolated)
2. RF probes in thermal equilibrium as devices during cal & measurement.



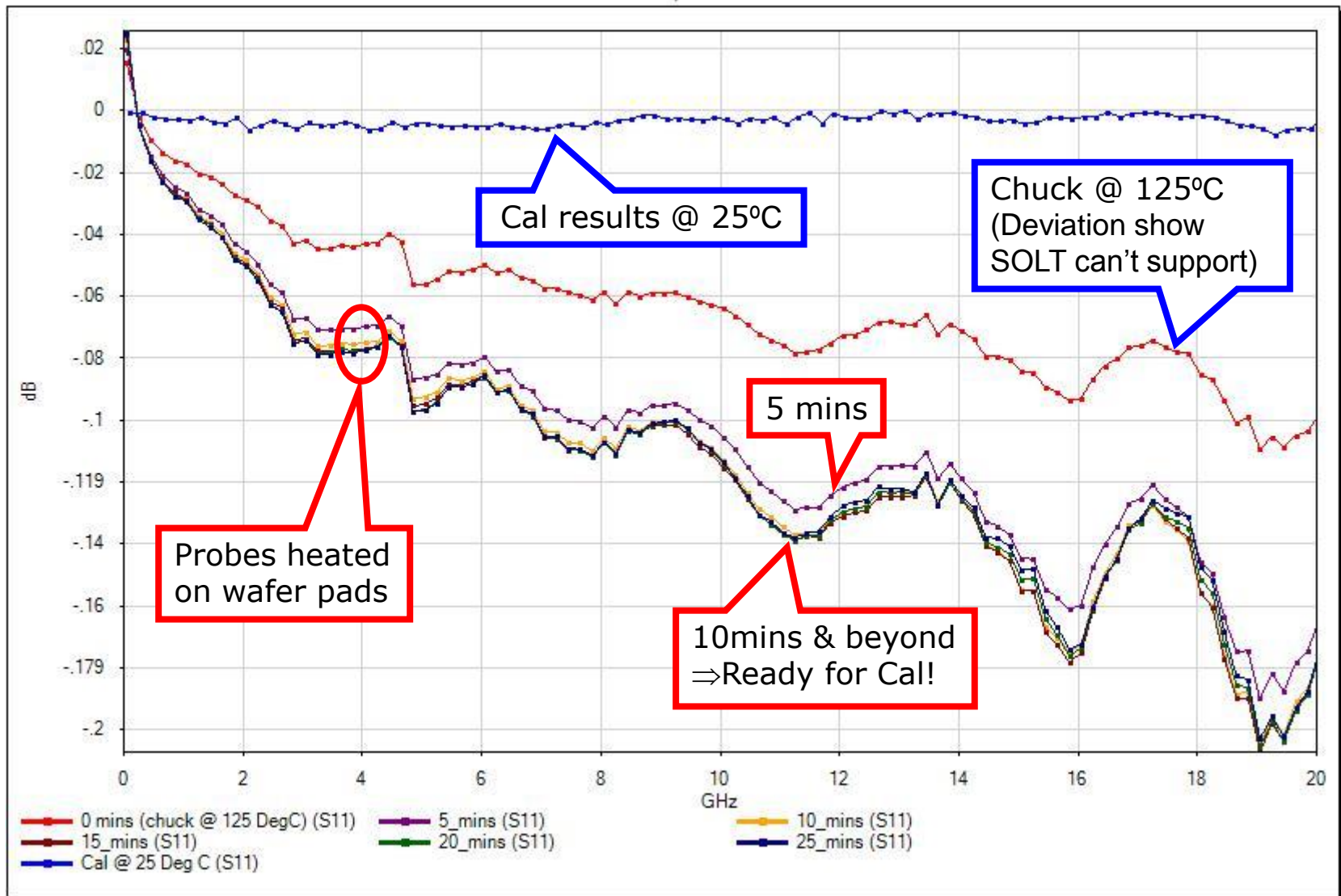
Recommended Flow for Over-temperature Cal

- How to check if probe in thermal equilibrium with DUT?
- Perform Stability Check
 - Lift Probes up in Air (OPEN)
 - Measure and Monitor S11 & S22
 - OPEN allow probe thermal stability checks anywhere.



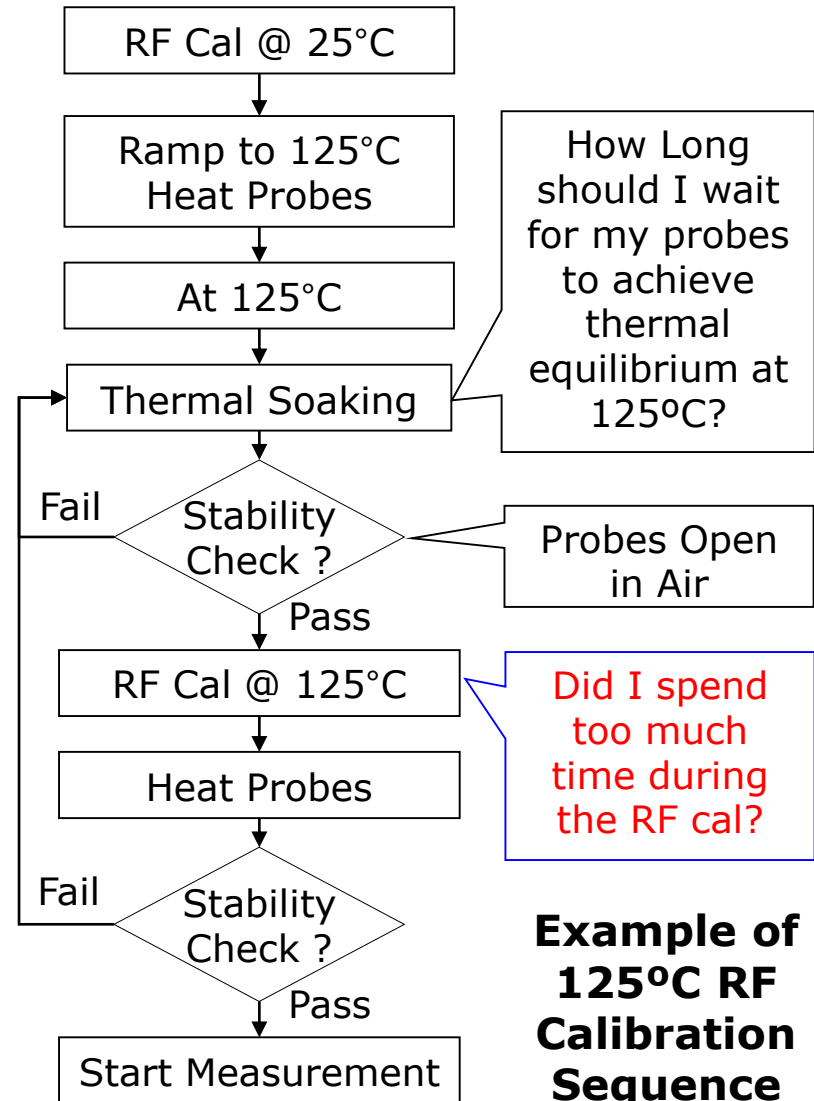
■ Deviation in Probe S11 OPEN (in Air)

1

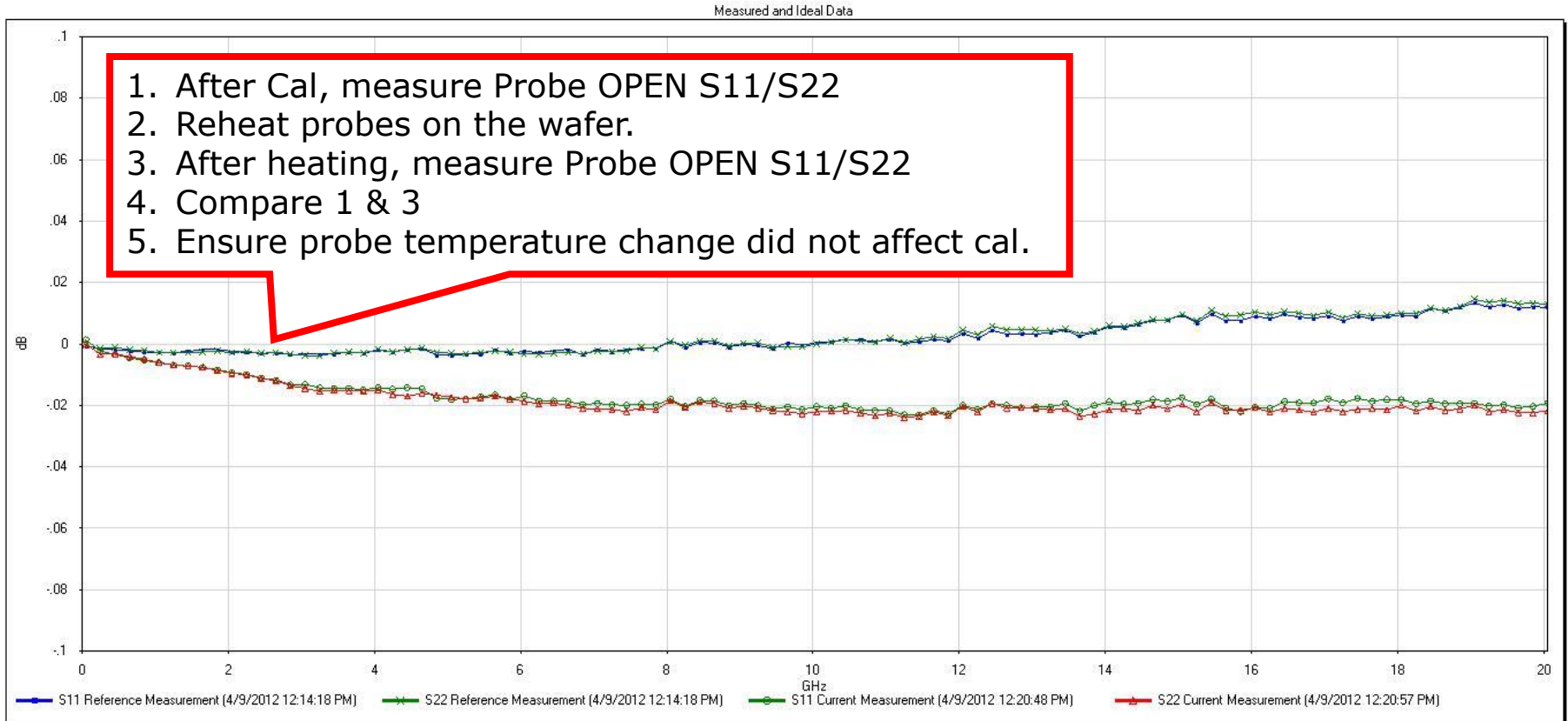


Recommended Flow for Over-temperature Cal

- How to check if probe in thermal equilibrium with DUT?
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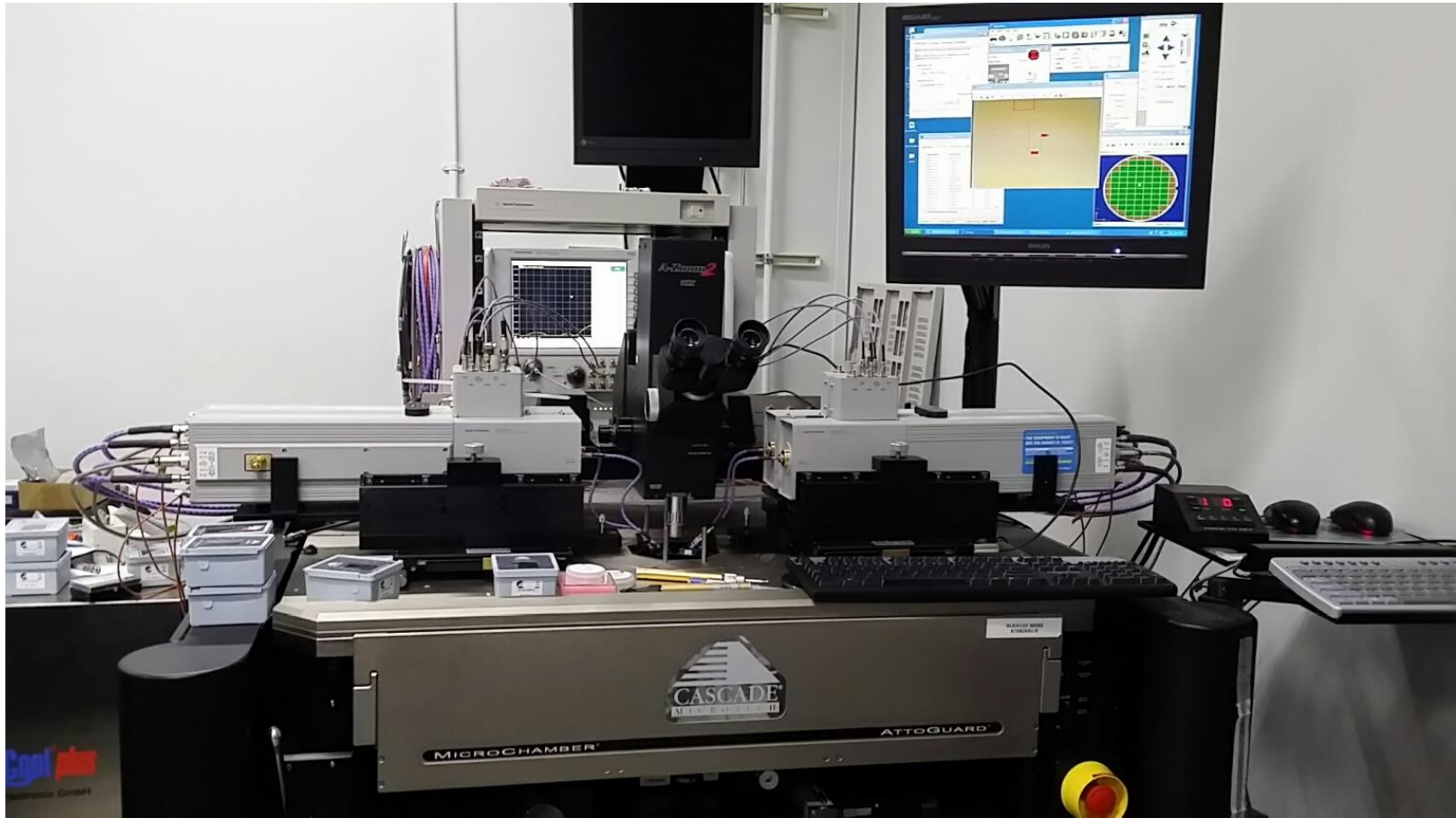
■ Checking Probe Thermal Stability after Cal



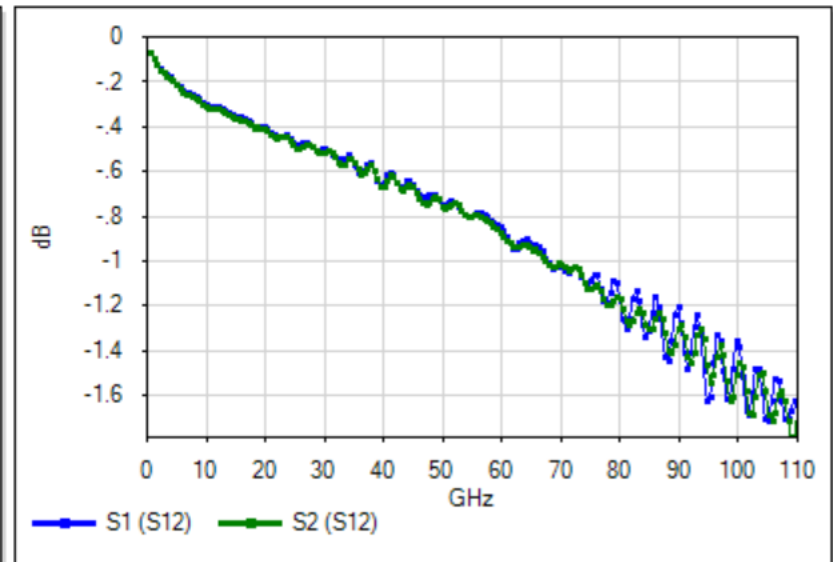
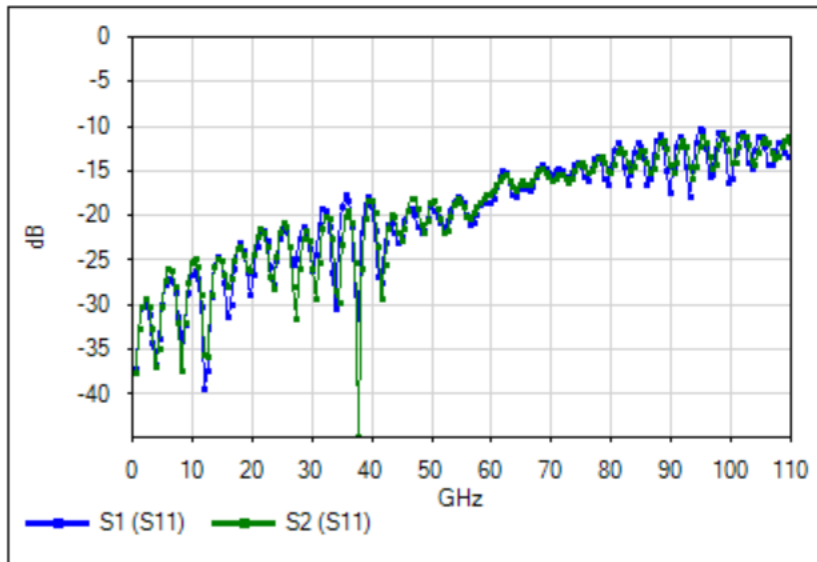
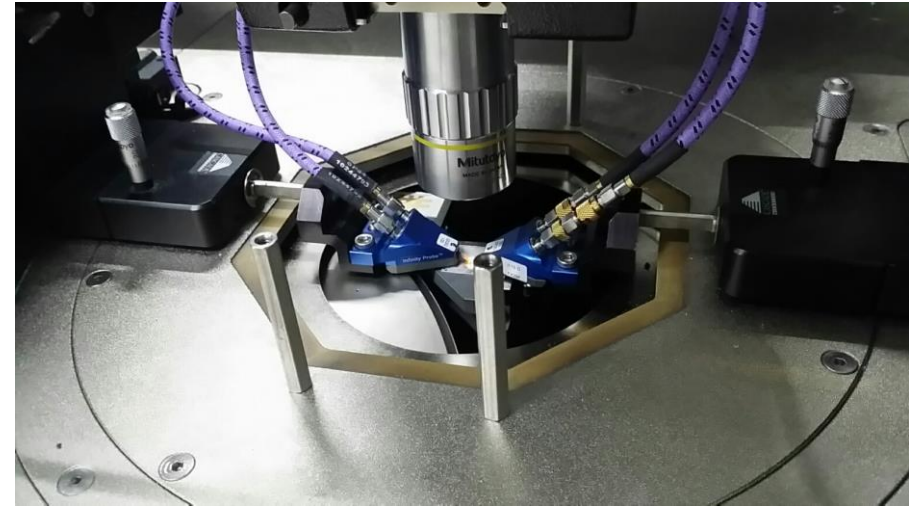
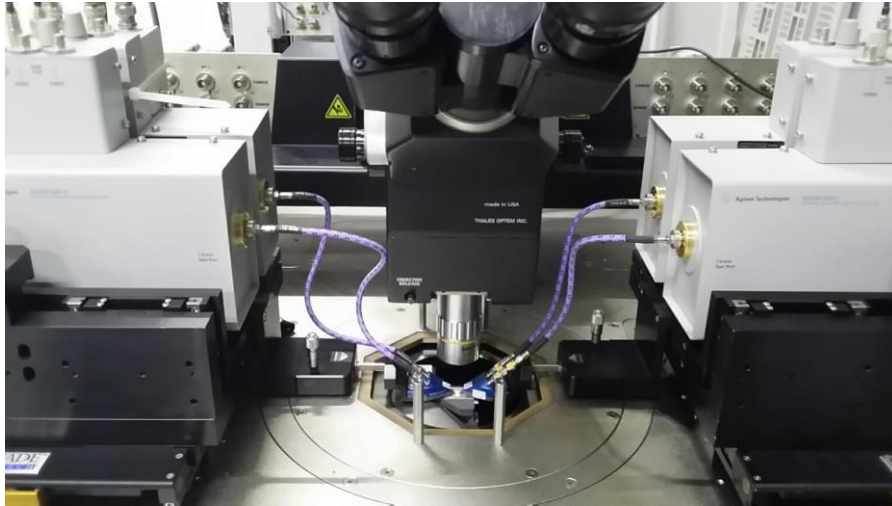


110 GHz 4 port Calibration using GSGSG probes

■ Cascade & Keysight 4 port 110 GHz Setup

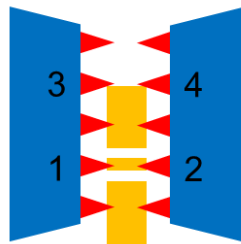


■ Cascade & Keysight 4 port 110 GHz Setup

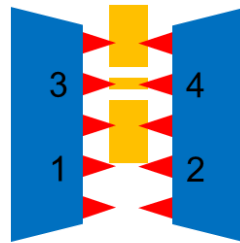


Unknown Thru' Calibration

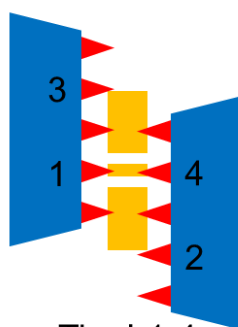
- Adopt unknown thru' calibration or SOLR calibration.
- SHORT-OPEN-LOAD for each ports on ISS (104-783).
- For the Thru' standard, adjust the probes to complete 4 thru' standards.



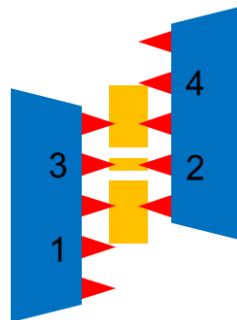
Thru' 1-2



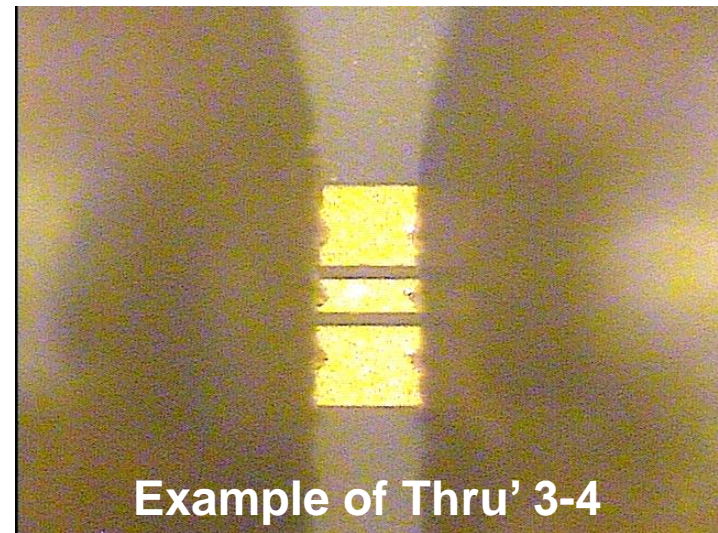
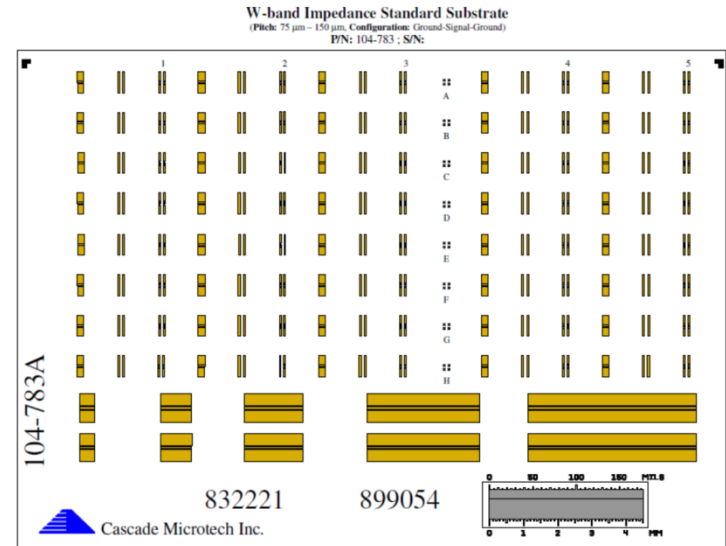
Thru' 3-4



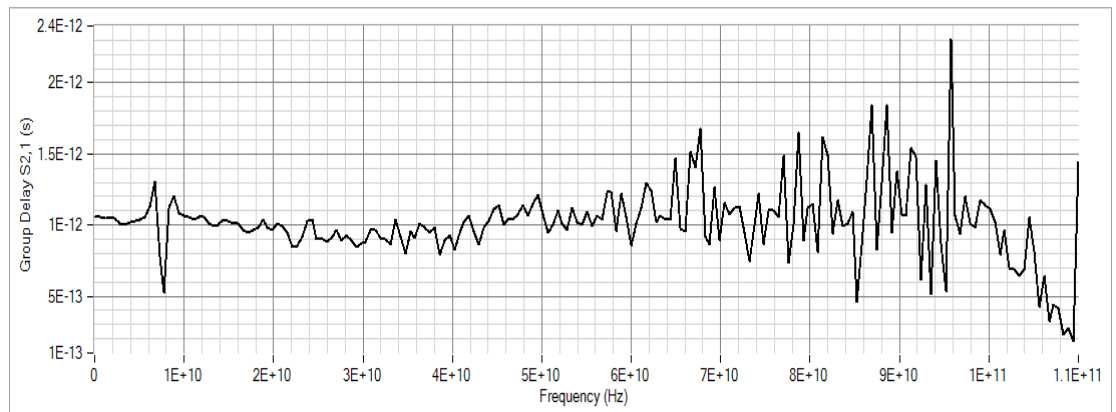
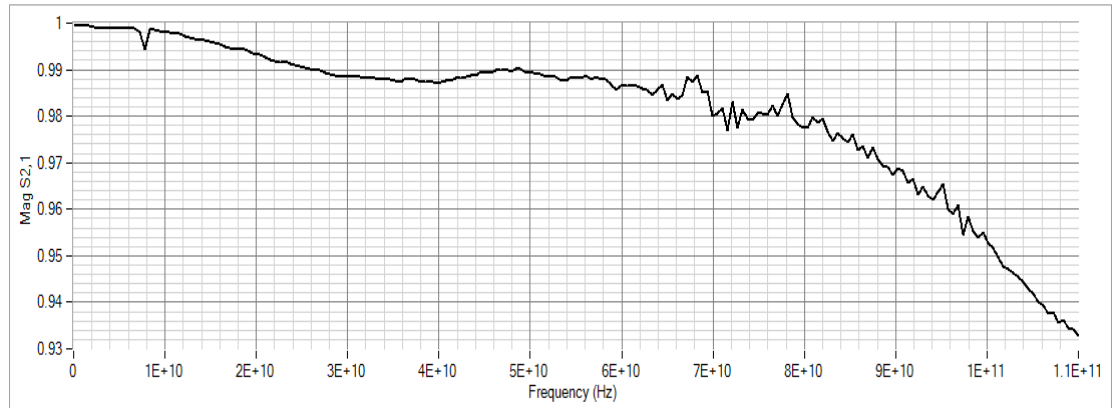
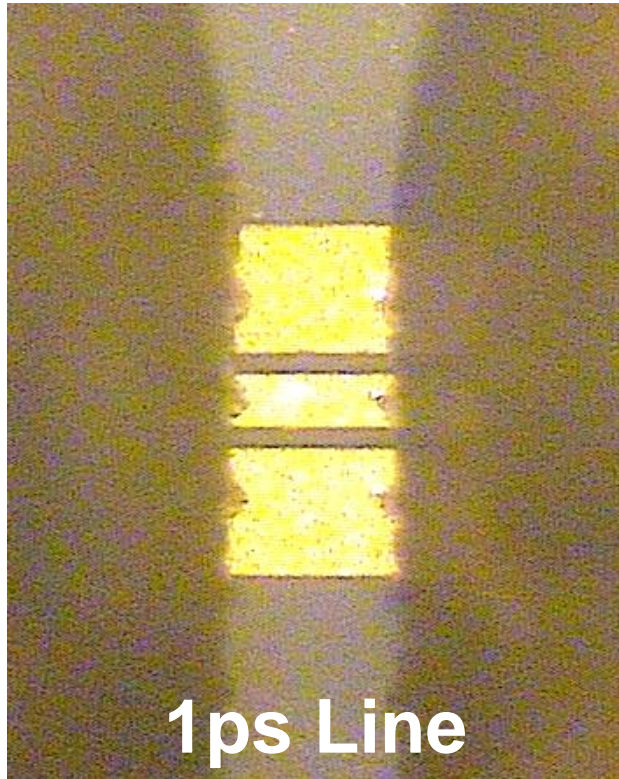
Thru' 1-4



Thru' 3-2

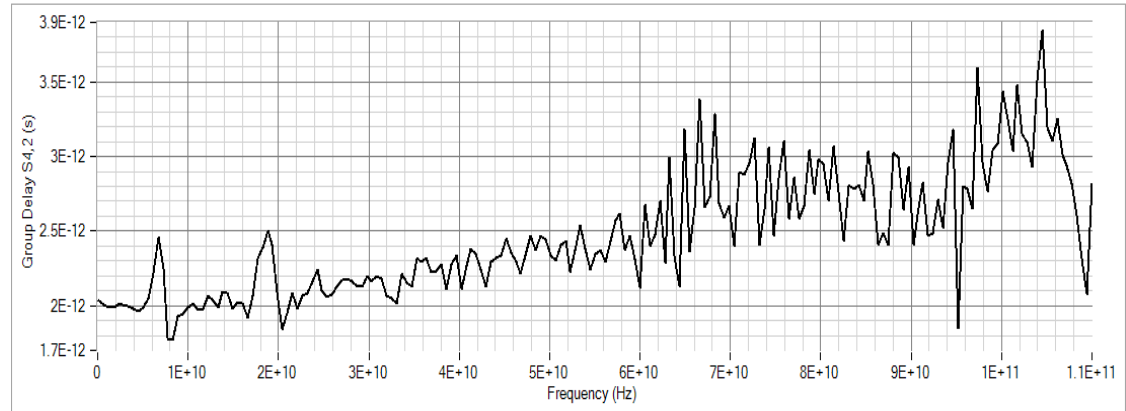
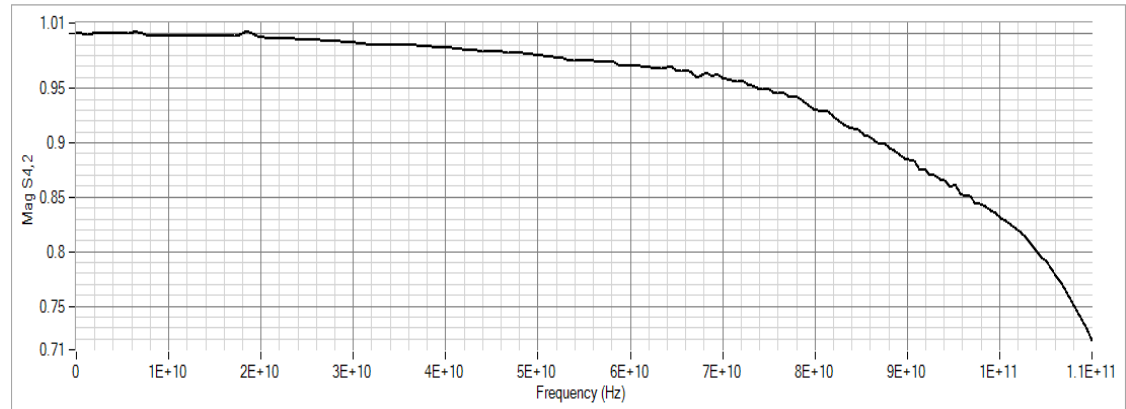
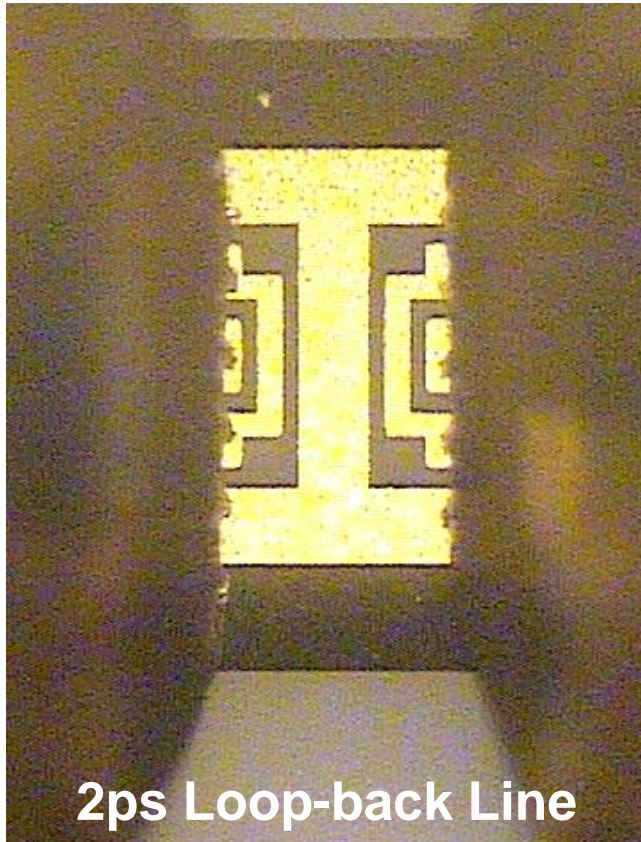


Port 3-4 Calibration Verification



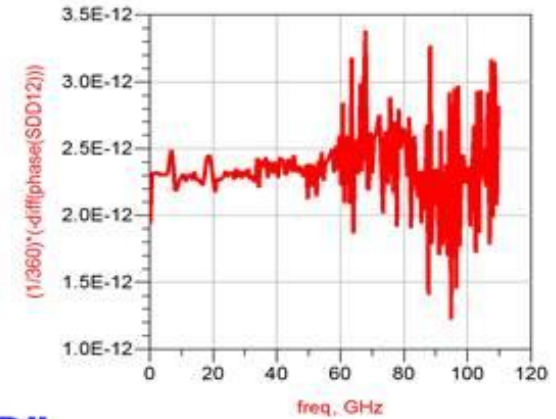
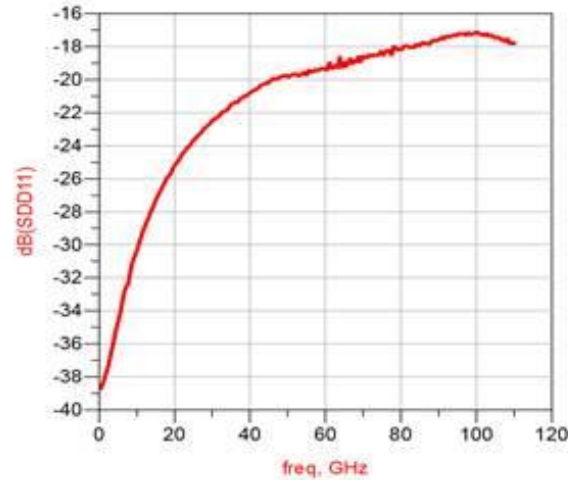
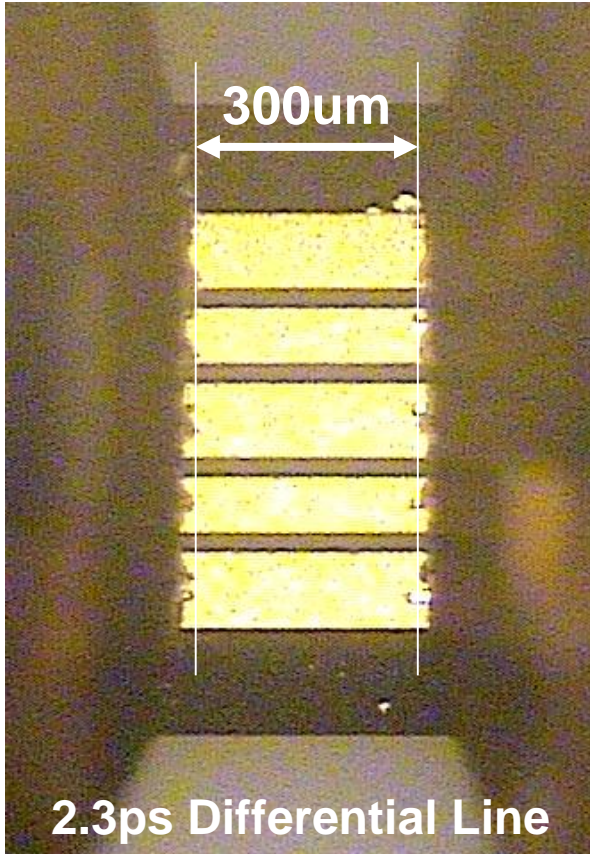
Delay valid up to 100GHz

Port 1-3 Calibration Verification

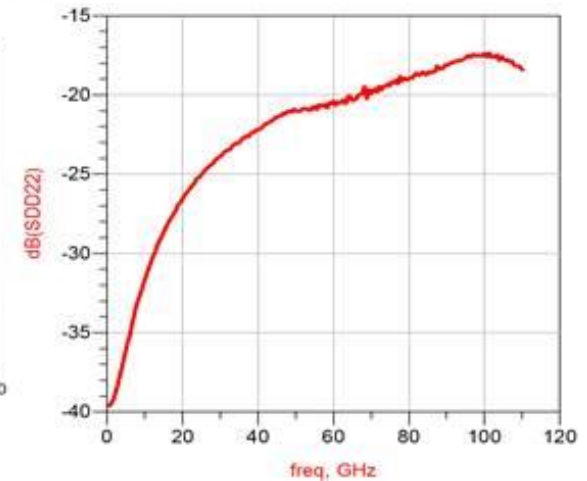
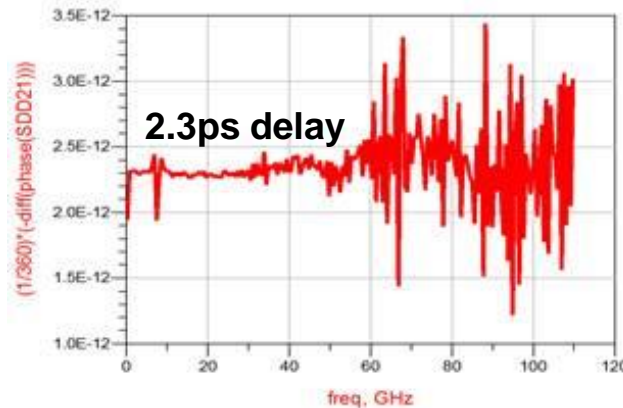


Increase in Delay due to increase in inductance

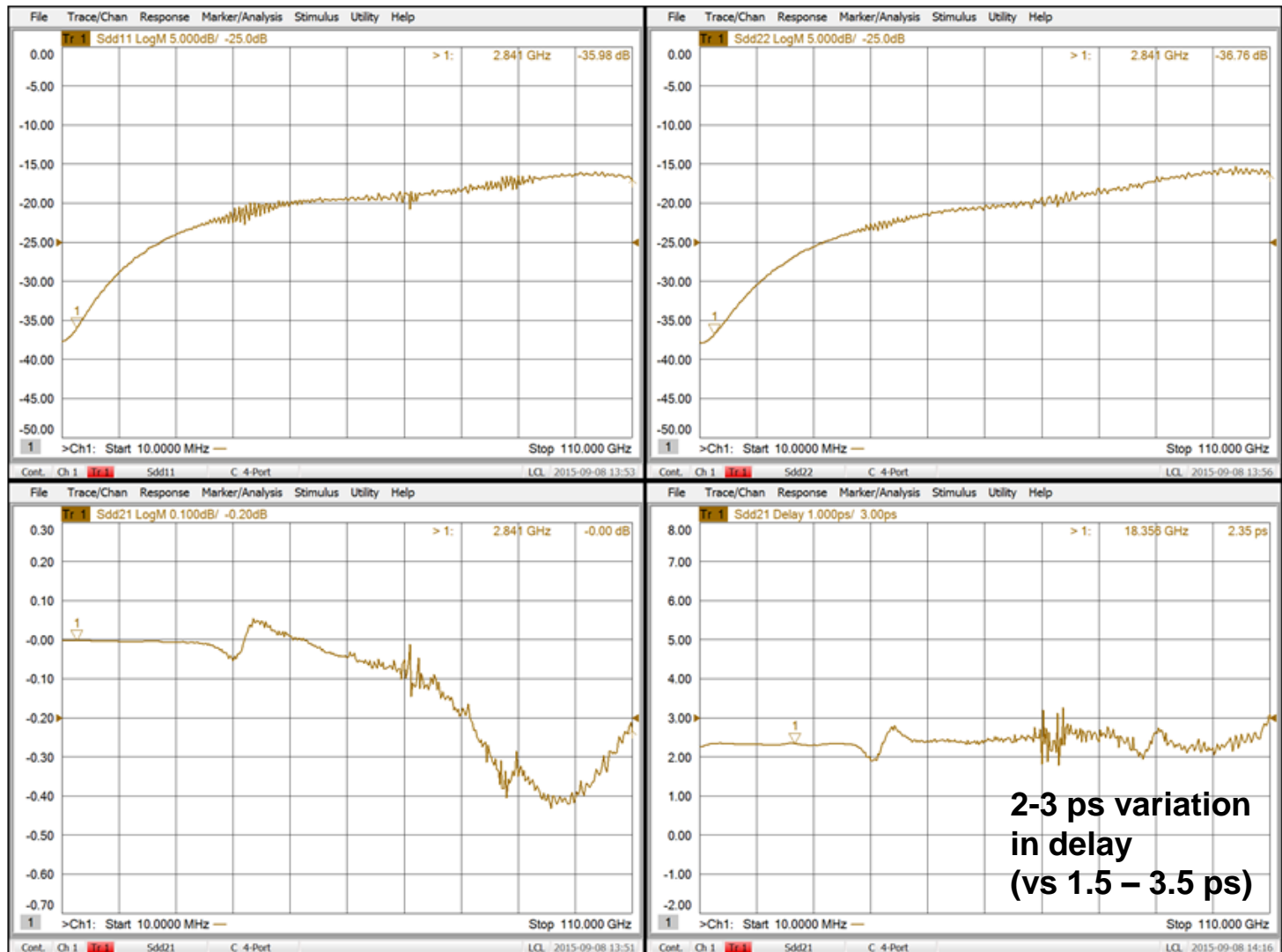
Differential Line



"DD"



Differential Line (WincalXE, 4 Port SOLR cal)

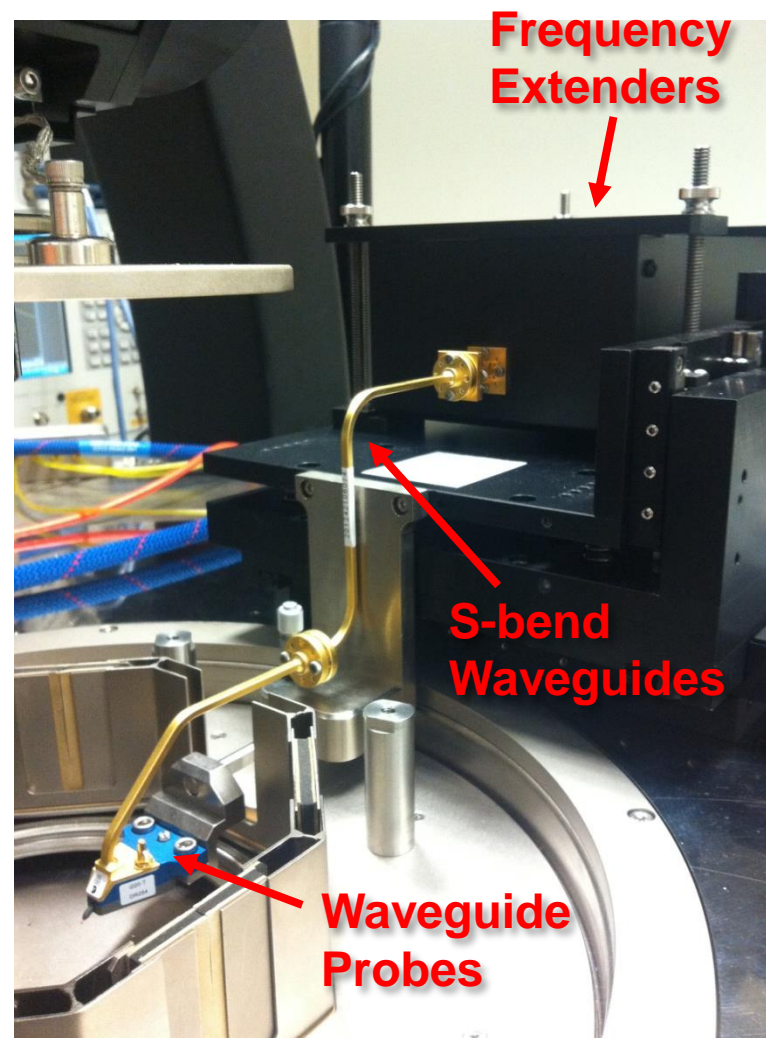




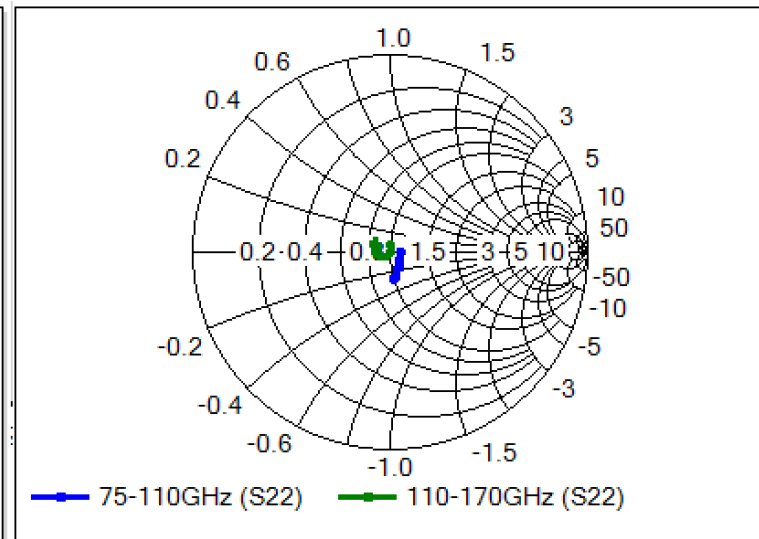
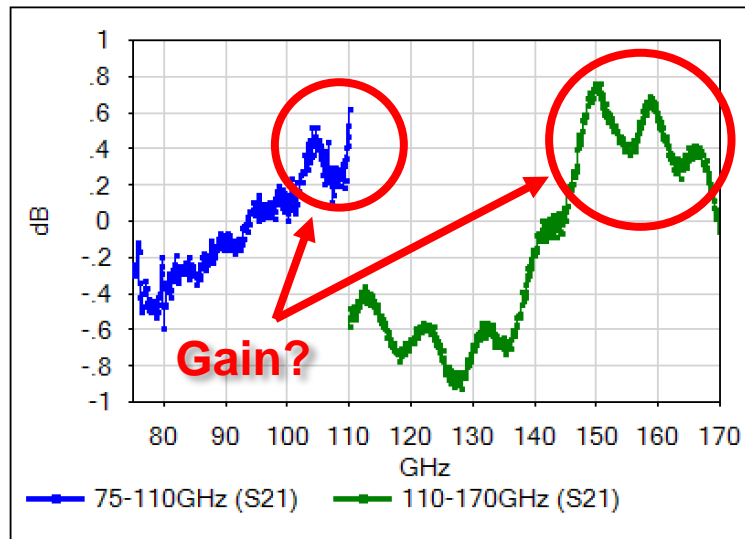
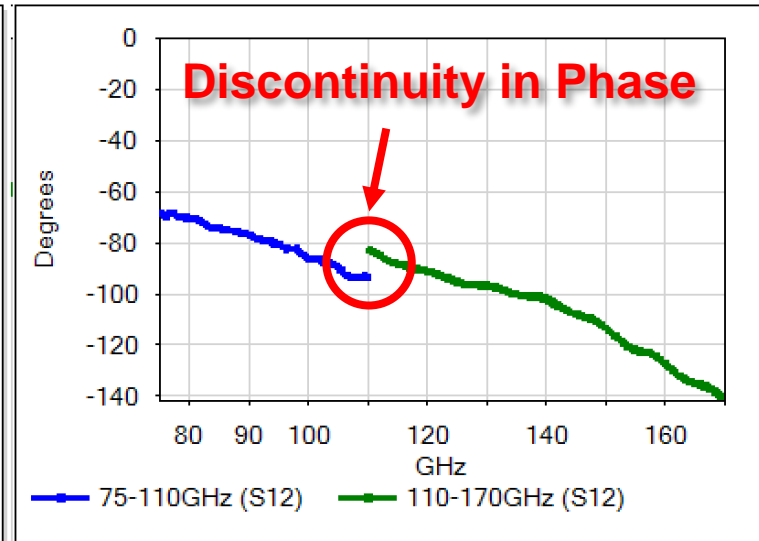
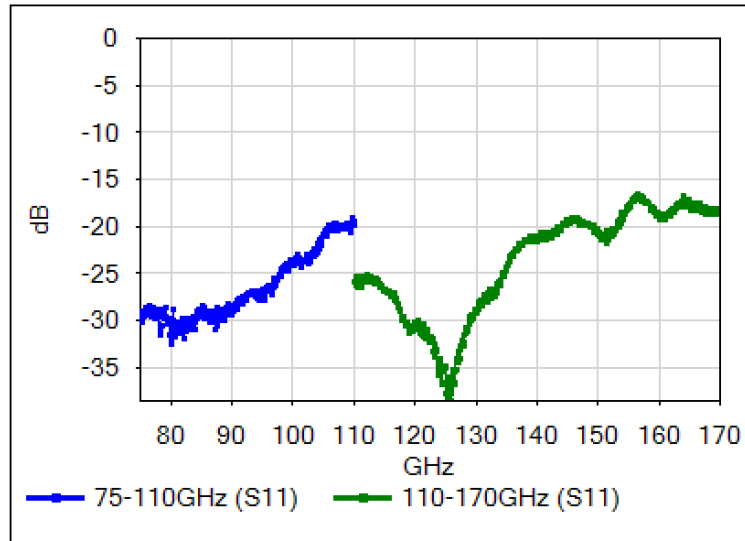
Sub-THz Wafer Level VNA Calibration

■ Challenges for Sub-THz Banded measurements

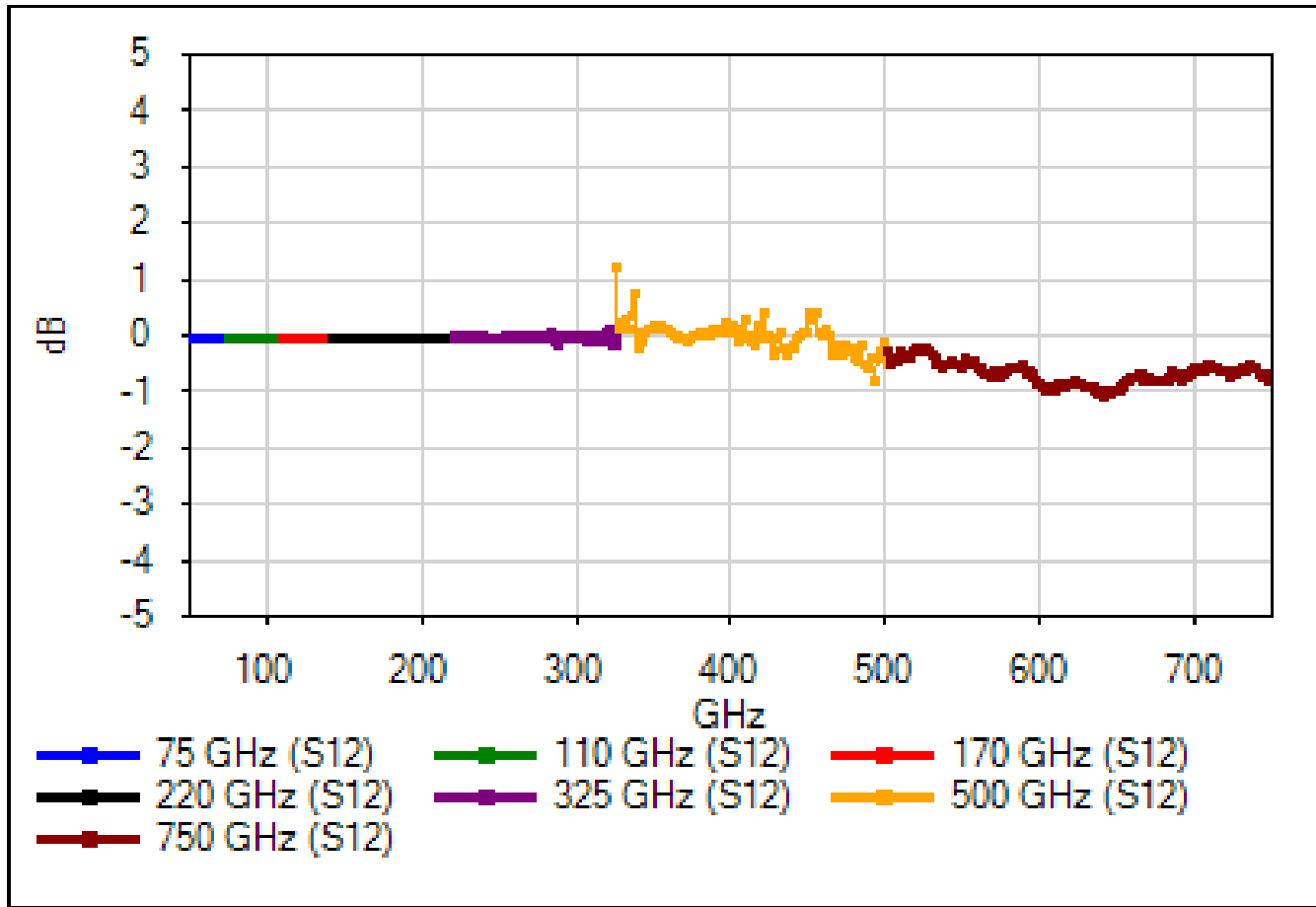
- Banded Calibration :- 50-75GHz, 90-140GHz, 110-170GHz, 140-220GHz, 220-325GHz and 325-500GHz.
- mmW tests on same device
 - Design TRL standards.
 - Setup Freq extenders, S-bends and waveguide probes for every frequency bands.
 - Perform calibration & measure device for every band - Tedious and time consuming.
- How to ensure calibration continuity and device measurement integrity for all frequency bands?



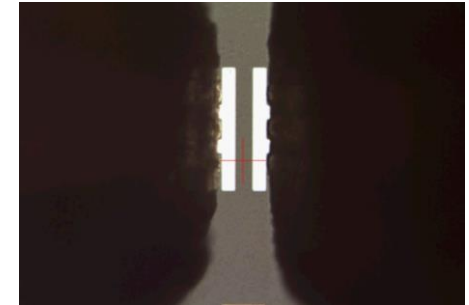
Example of Data Discontinuity (160um Line)



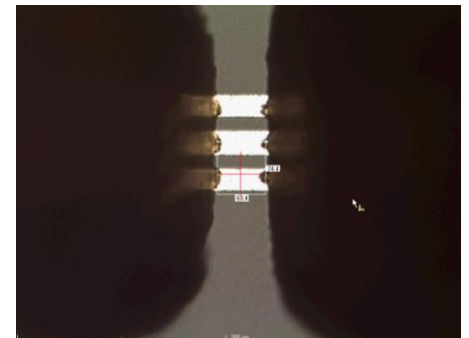
How to Verify Calibration Continuity?



Magnitude S21 on 0.5ps Line

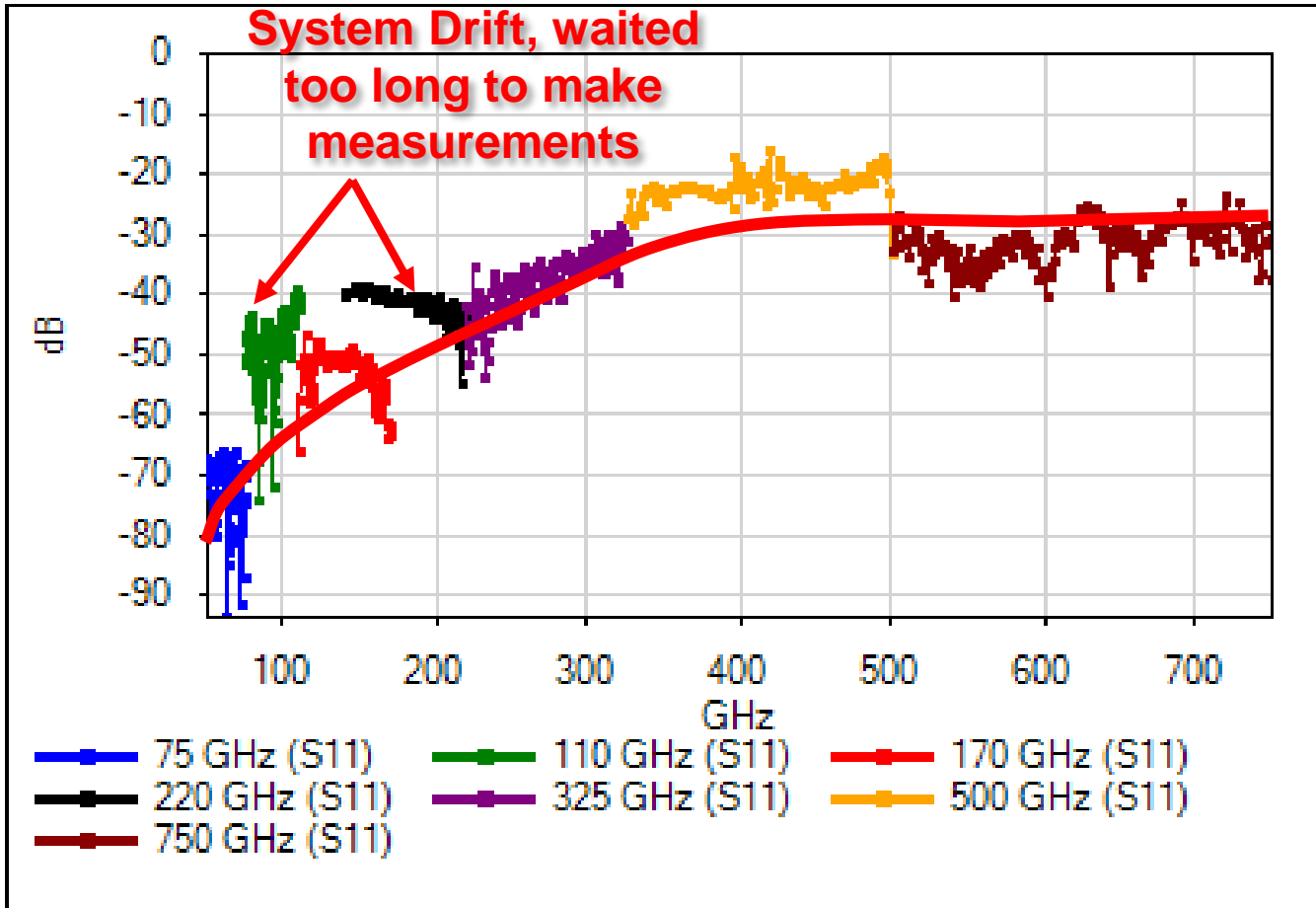


Aligning Probes

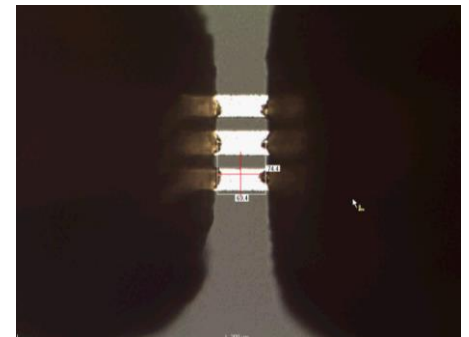


0.5ps Line

How to Verify Calibration Continuity?



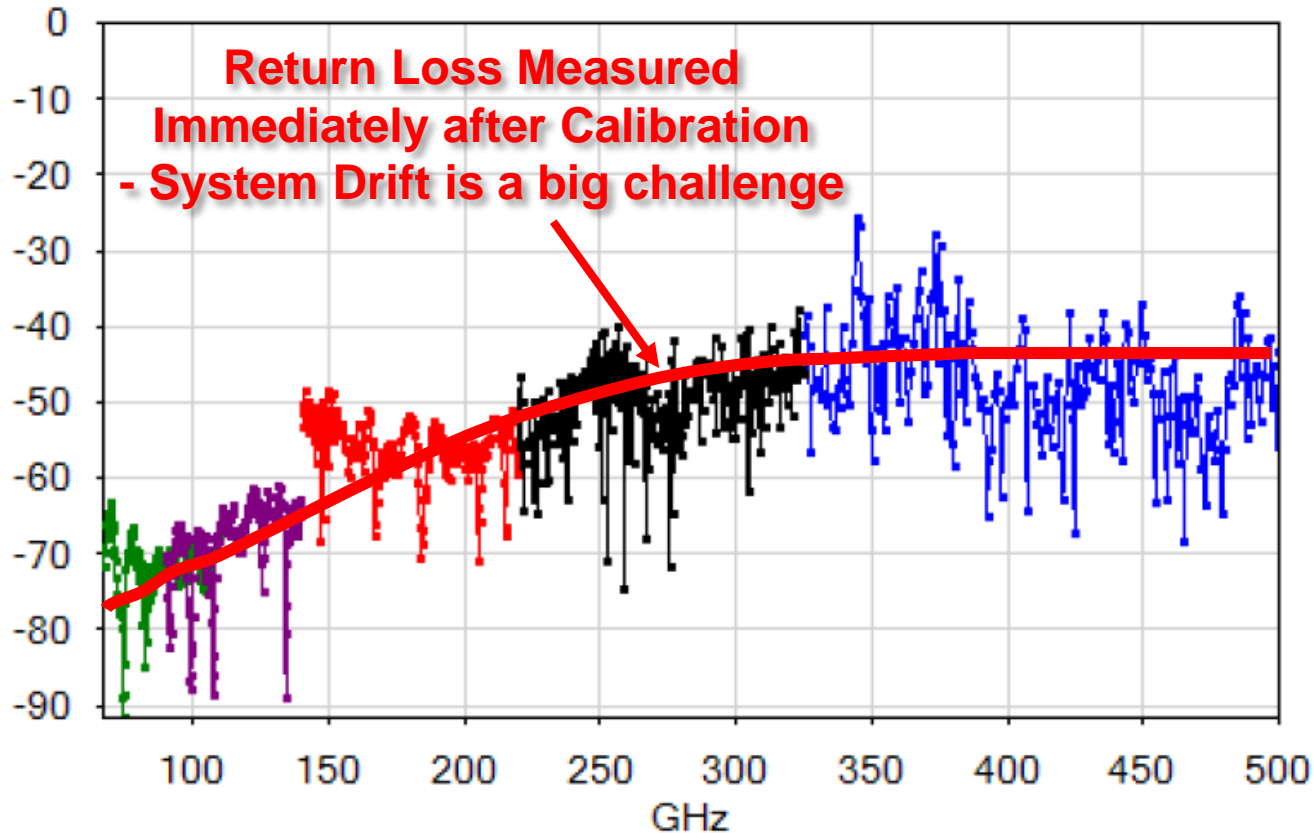
Aligning Probes



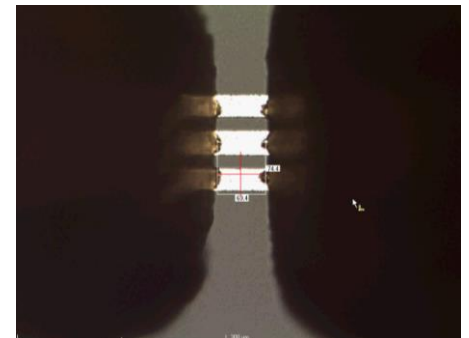
0.5ps Line

Return Loss on 0.5ps Line

How to Verify Calibration Continuity?



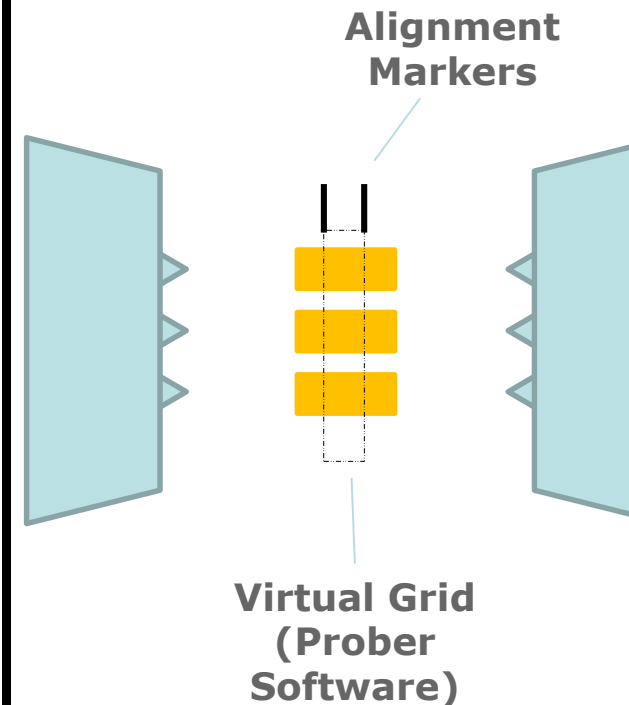
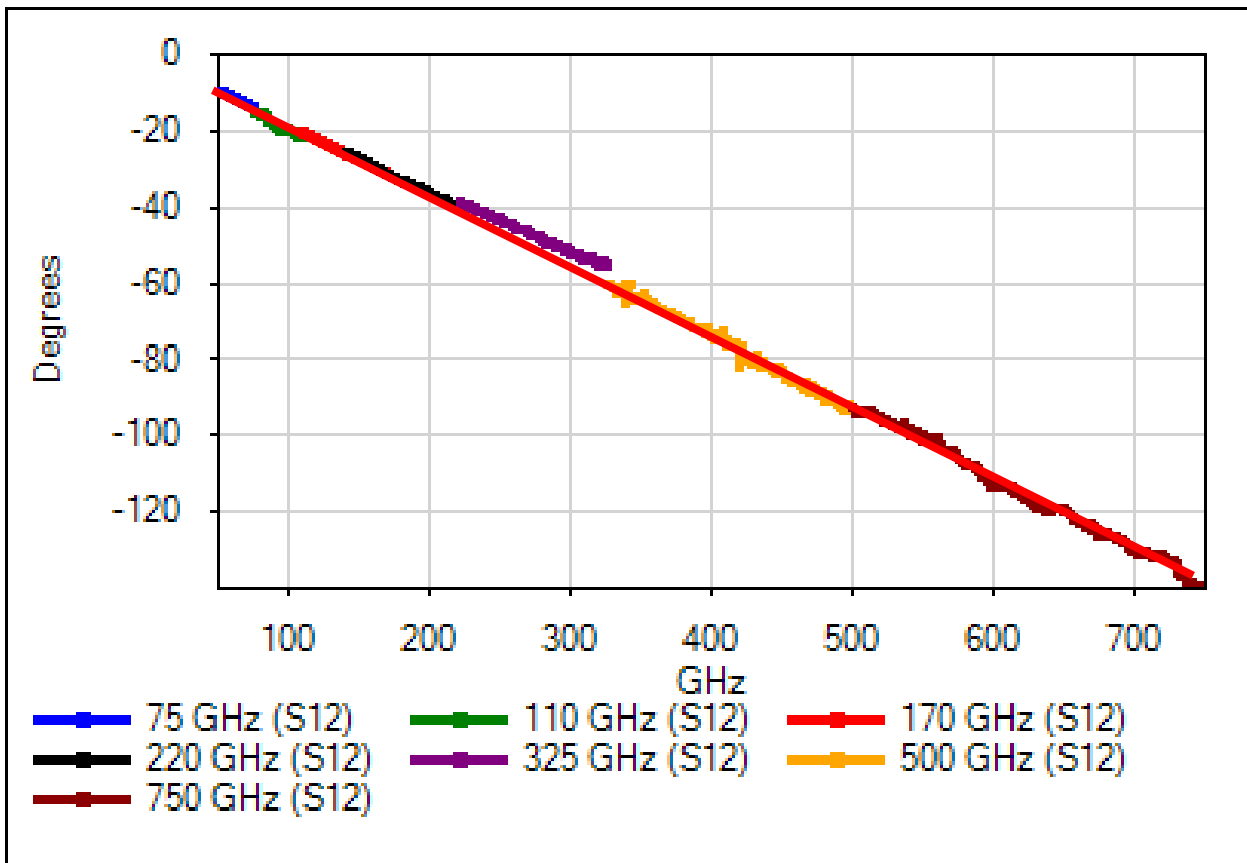
**Aligning
Probes**



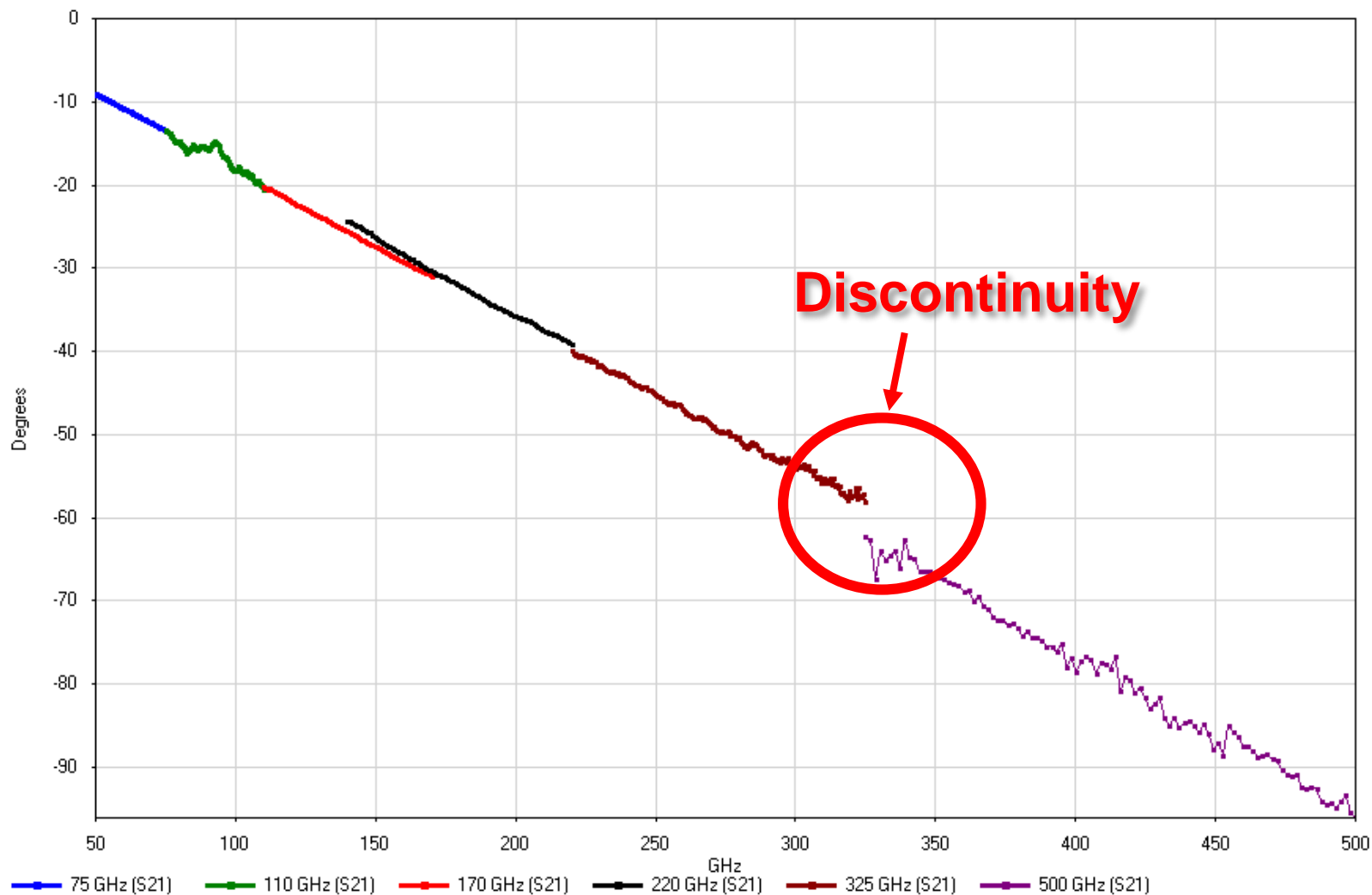
0.5ps Line

■ Verifying Calibration Continuity

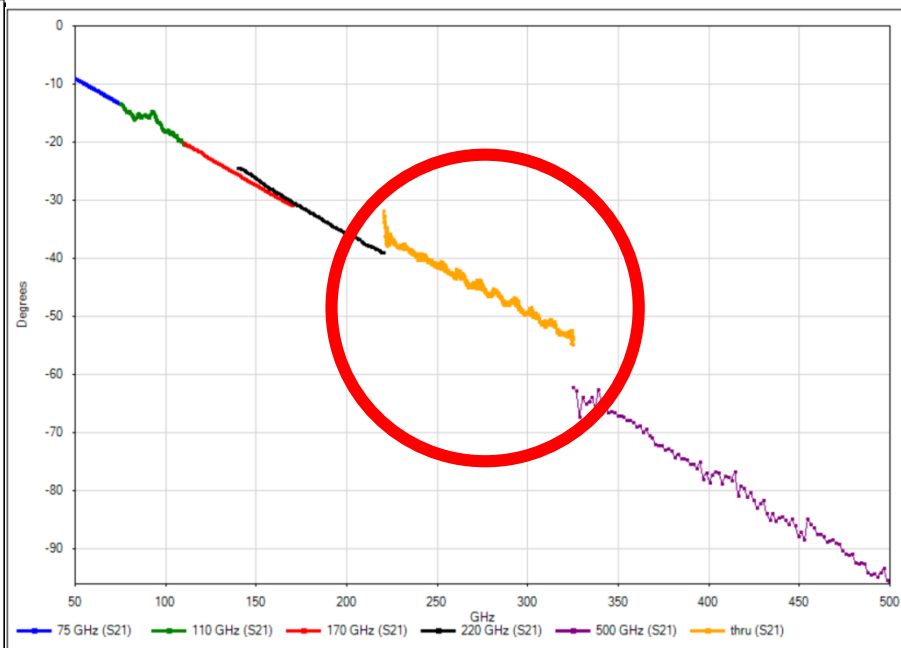
- Design verification line with alignment markers on wafer.
- Characterize same line for all bands after TRL cal (or LRRM cal).
- Plot all bands, Phase S12 or S21 (group delay can be used too)
- Use plot as reference – ensure Measurement Continuity & Integrity.



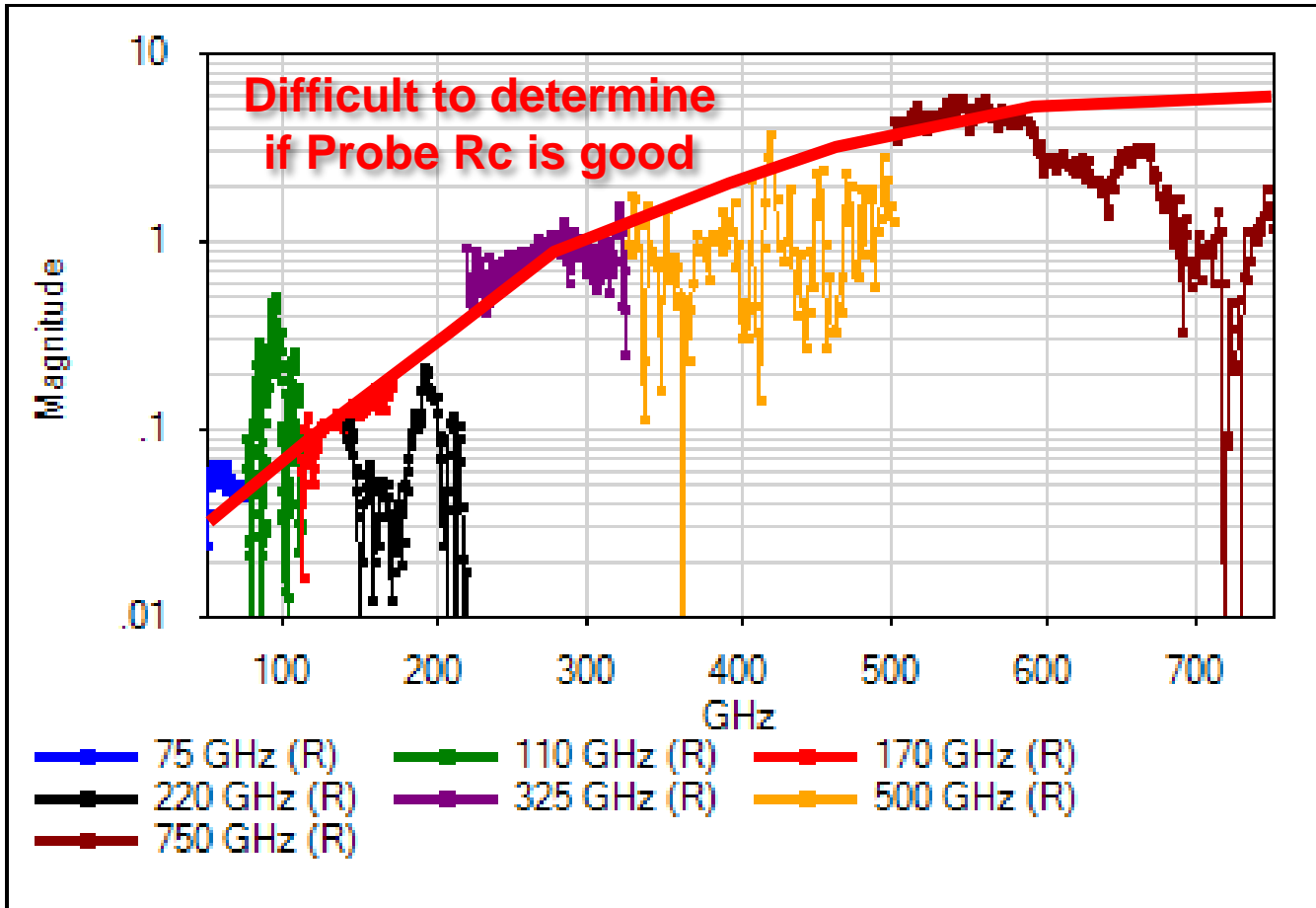
Example of 325 GHz cal – Discontinuity in Test Data



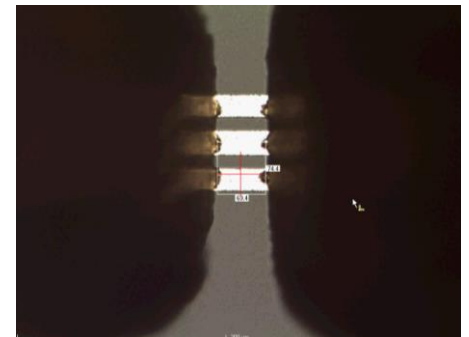
Example of 325 GHz cal – Discontinuity in Test Data



■ Ensure Continuity in Contact Resistance?



Aligning Probes

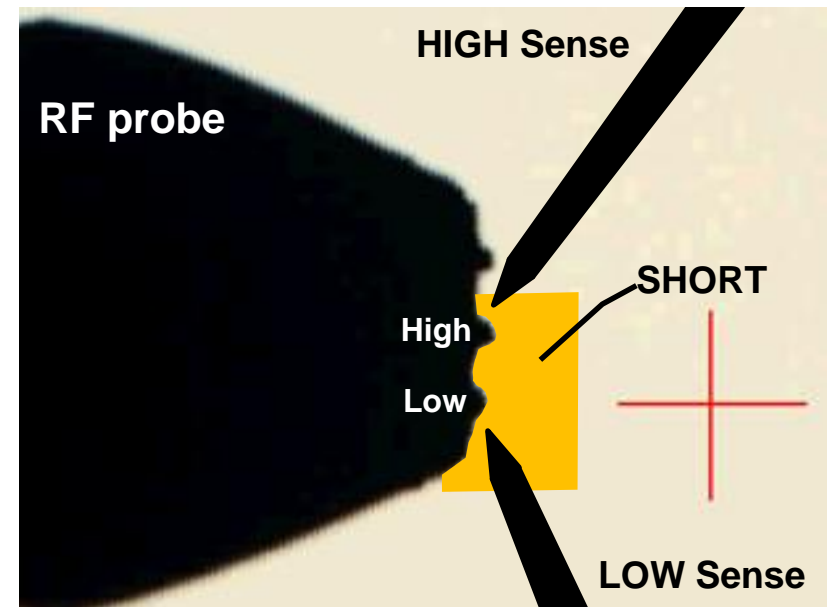


0.5ps Line

Extracted $2 \times \text{Probe } R_c + \text{Line Resistance}$

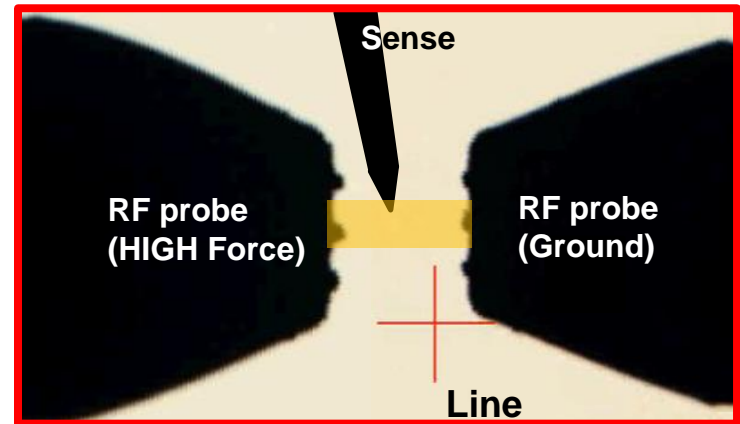
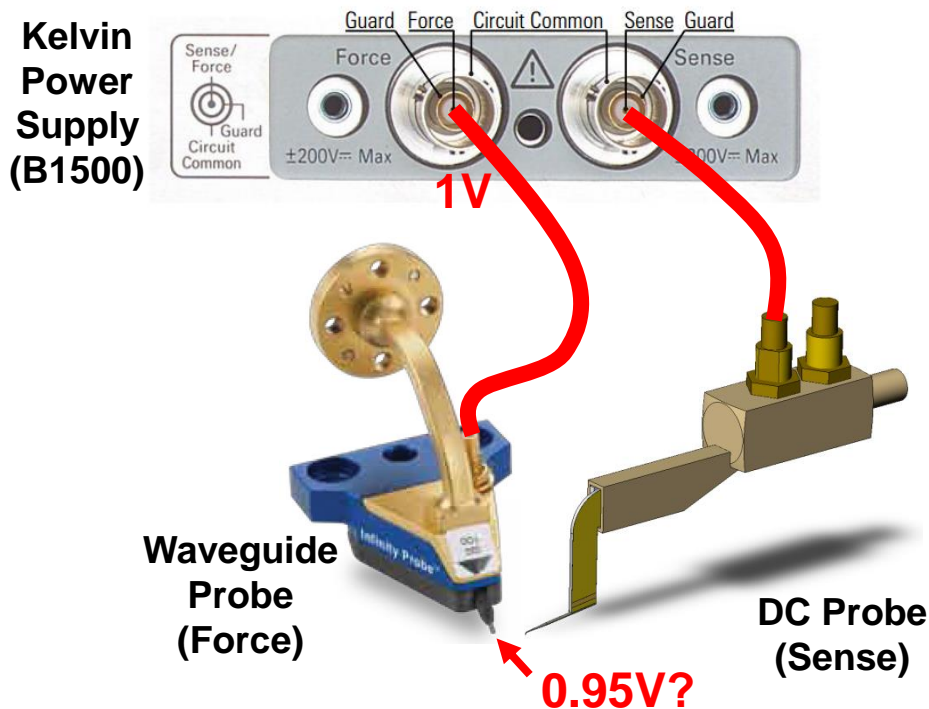
■ Ensure Continuity in Contact Resistance?

- Check DC contact resistance for each set of waveguide probes (20-50 milliohm range)
 - Contacting probes Short Structure Design on Wafer
 - Additional DC probes (for True Kelvin measurement) to measure R_c of the waveguide probes.



■ Ensure Continuity in Biasing Voltage

- Ensure same Voltage is applied to Device terminals.
 - Correct Series Resistance from Cabling, Probe Bias Tee Network, Probe tips contact for every frequency band setup.
 - Use Voltmeter if power supply has no sense capability



■ Summary

- Choose the calibration method which,
 - Requires minimal info of the calibration standards
 - Insensitive to Probe Placement
- Always verify with known devices after calibration.
- Over-temperature Calibration
 - Ensure standards are thermally isolated
 - Ensure probes are in thermal equilibrium as Device/Wafer
- Unknown Thru' or SOLR calibration to support 110 GHz 4 port calibration.
- For Banded Calibration,
 - Check Probe R_{DC} , Design & use alignment markers to ensure consistent probe placement
 - Ensure data integrity and continuity



Thank You

Questions – Email to choonbeng.sia@cmicro.com